

# ***Multi-scale multi-physics modelling of photovoltaic systems: a co- development approach***

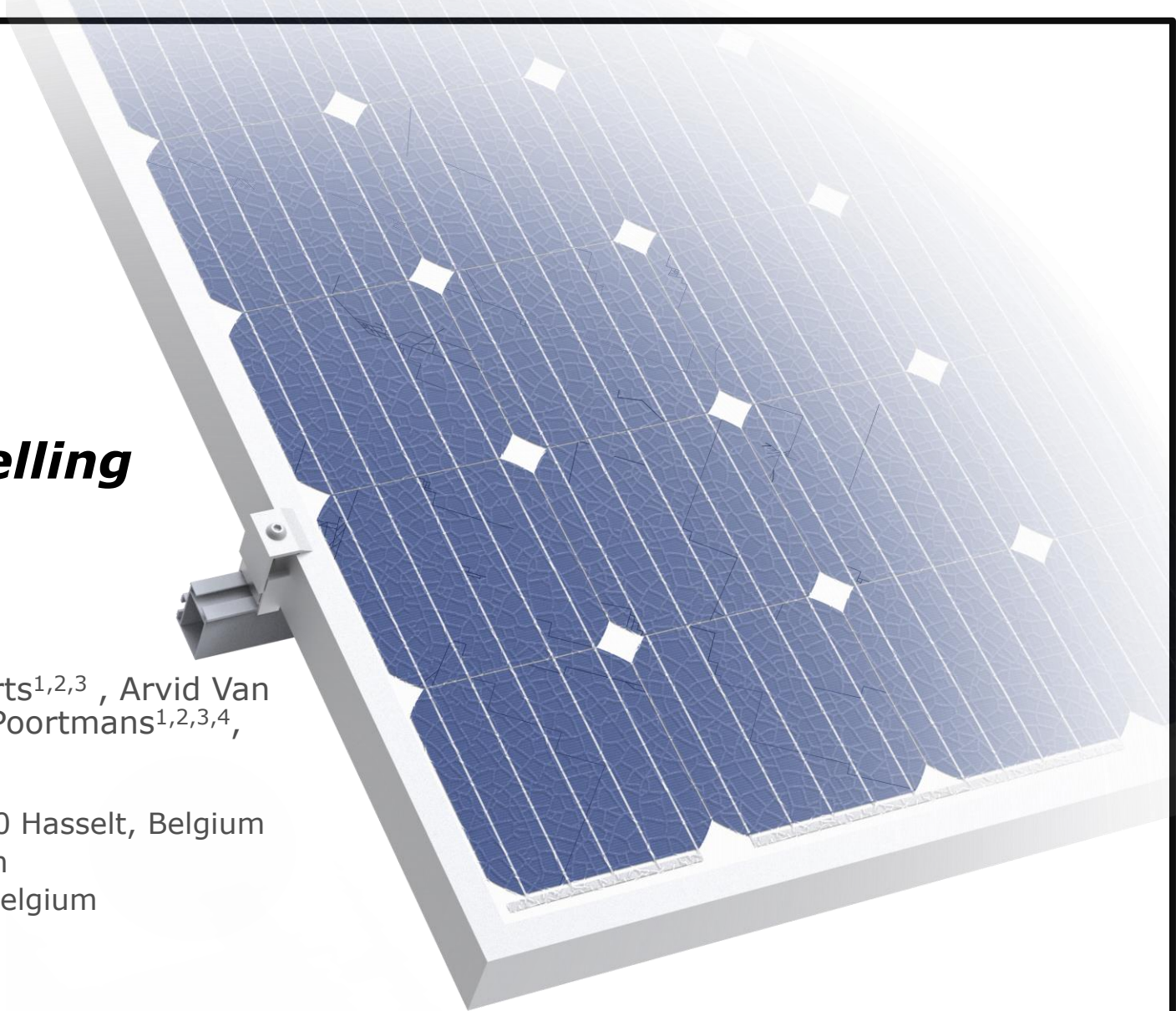
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<sup>1</sup> Hasselt University, imo-imomec, Martelarenlaan 42, 3500 Hasselt, Belgium

<sup>2</sup> Imec, imo-imomec, Thor Park 8320, 3600 Genk, Belgium

<sup>3</sup> EnergyVille, imo-imomec, Thor Park 8320, 3600 Genk, Belgium

<sup>4</sup> KULeuven, Oude markt 13, 3000 Leuven, Belgium



IMO-IMOMEC

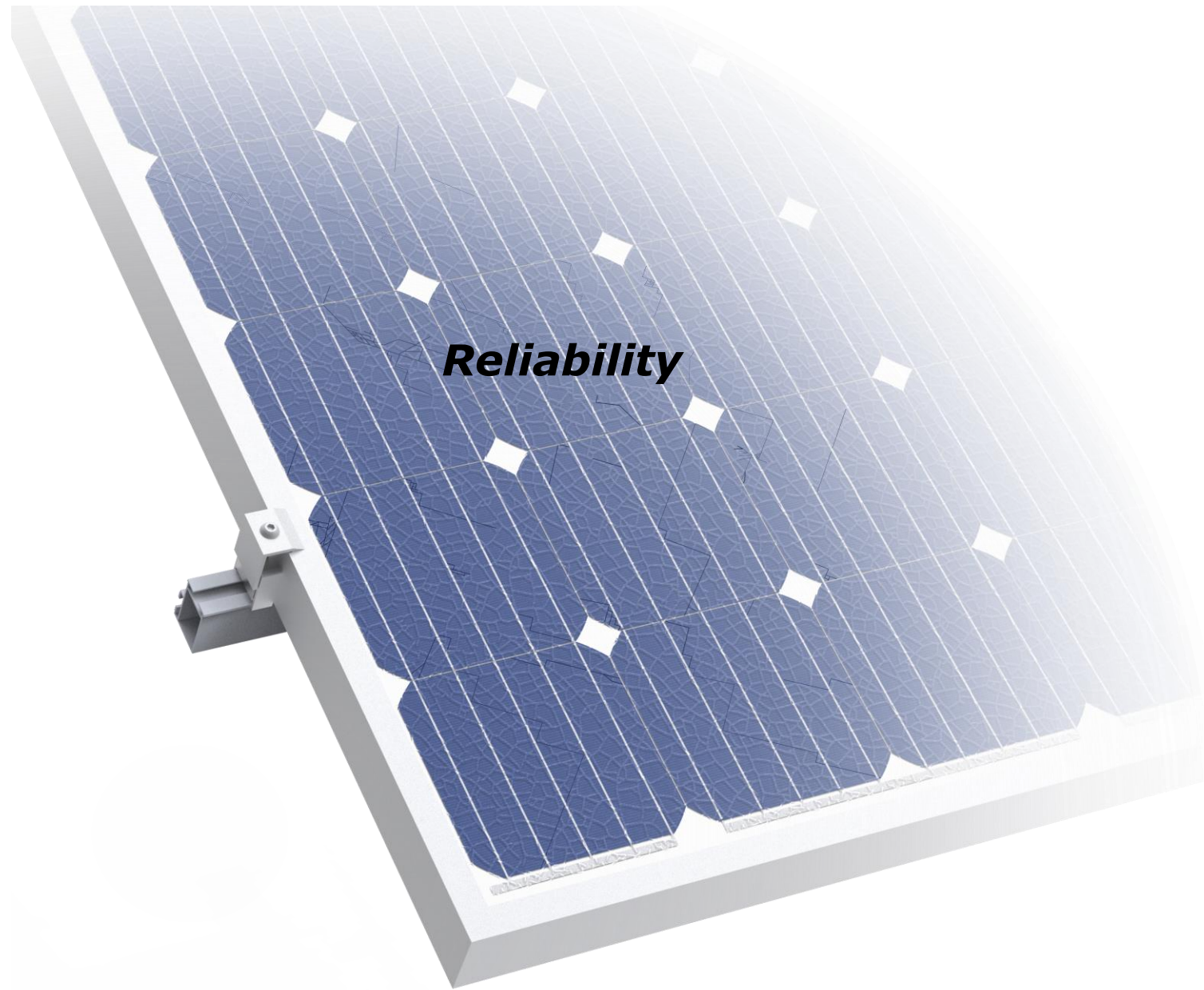


imec

# Overview

- ✓ Motivation
- ✓ Multi-scale nature of reliability
- ✓ Multi-scale Multiphysics reliability framework
- ✓ A case-study: PV module clamping/mounting systems
- ✓ Moving from indirect to direct validation
- ✓ PV-sense
  - ✓ Working principle
  - ✓ Investigating lamination
  - ✓ Investigating thermal cycling
  - ✓ Full size field monitoring
- ✓ A co-development approach
- ✓ Acknowledgements

# Motivation



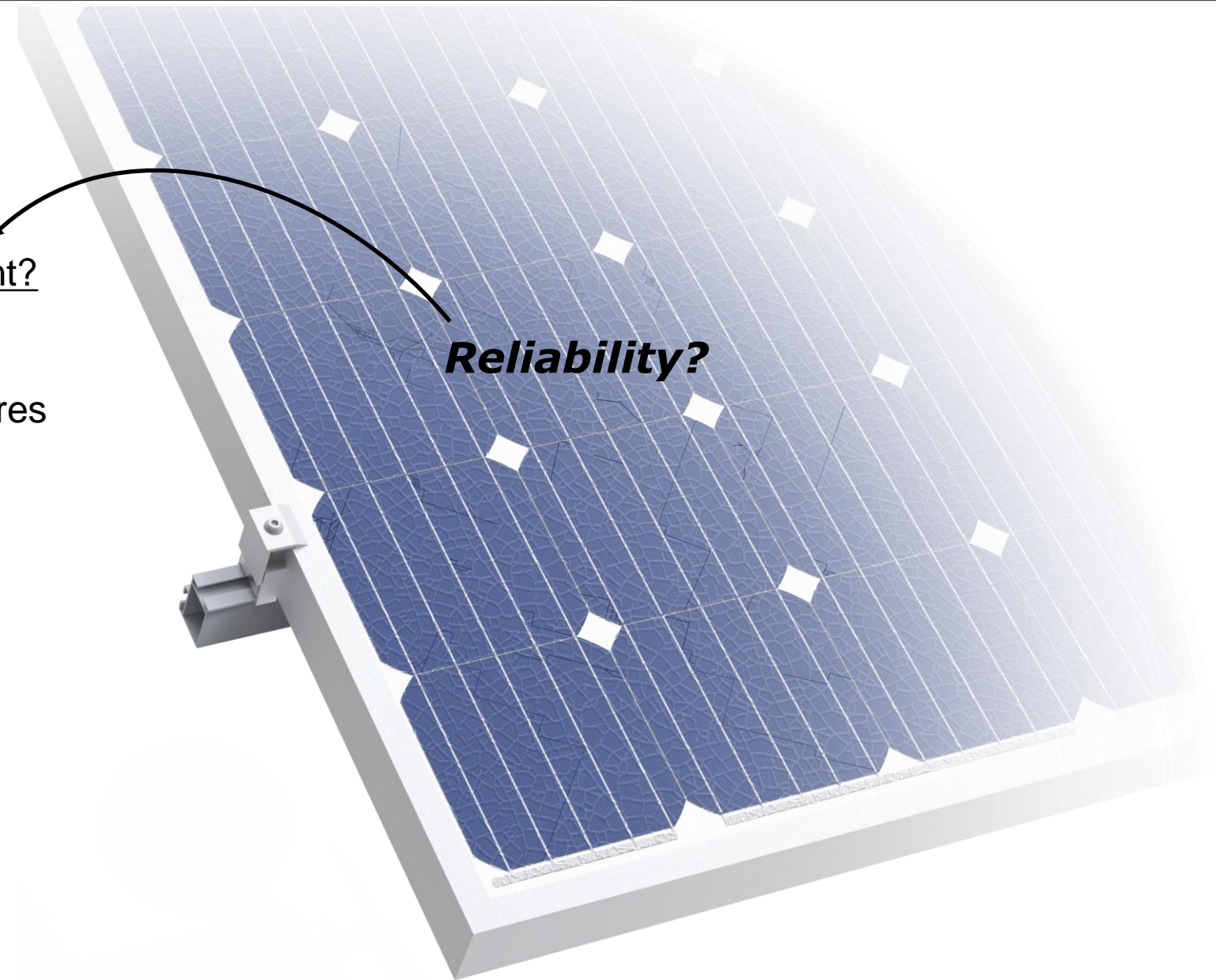


# Motivation

## Climate/Environment?

- Irradiation
- Wind speeds
- Ambient temperatures
- Soiling
- Shading
- Hail

***Reliability?***



# Motivation

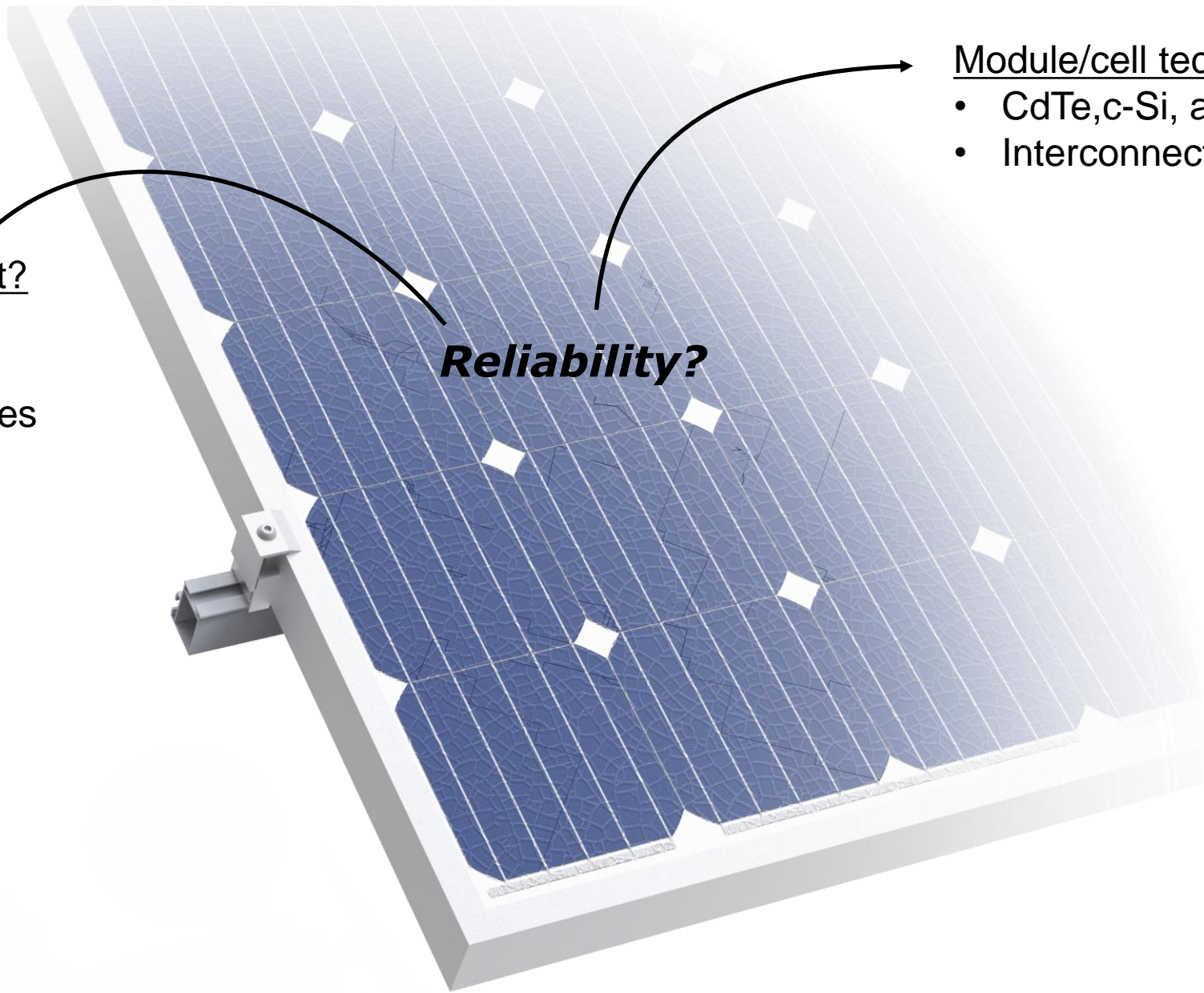
## Climate/Environment?

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## ***Reliability?***

## Module/cell technologies?

- CdTe, c-Si, a-Si, GaAs, CiGS, ...
- Interconnection technology





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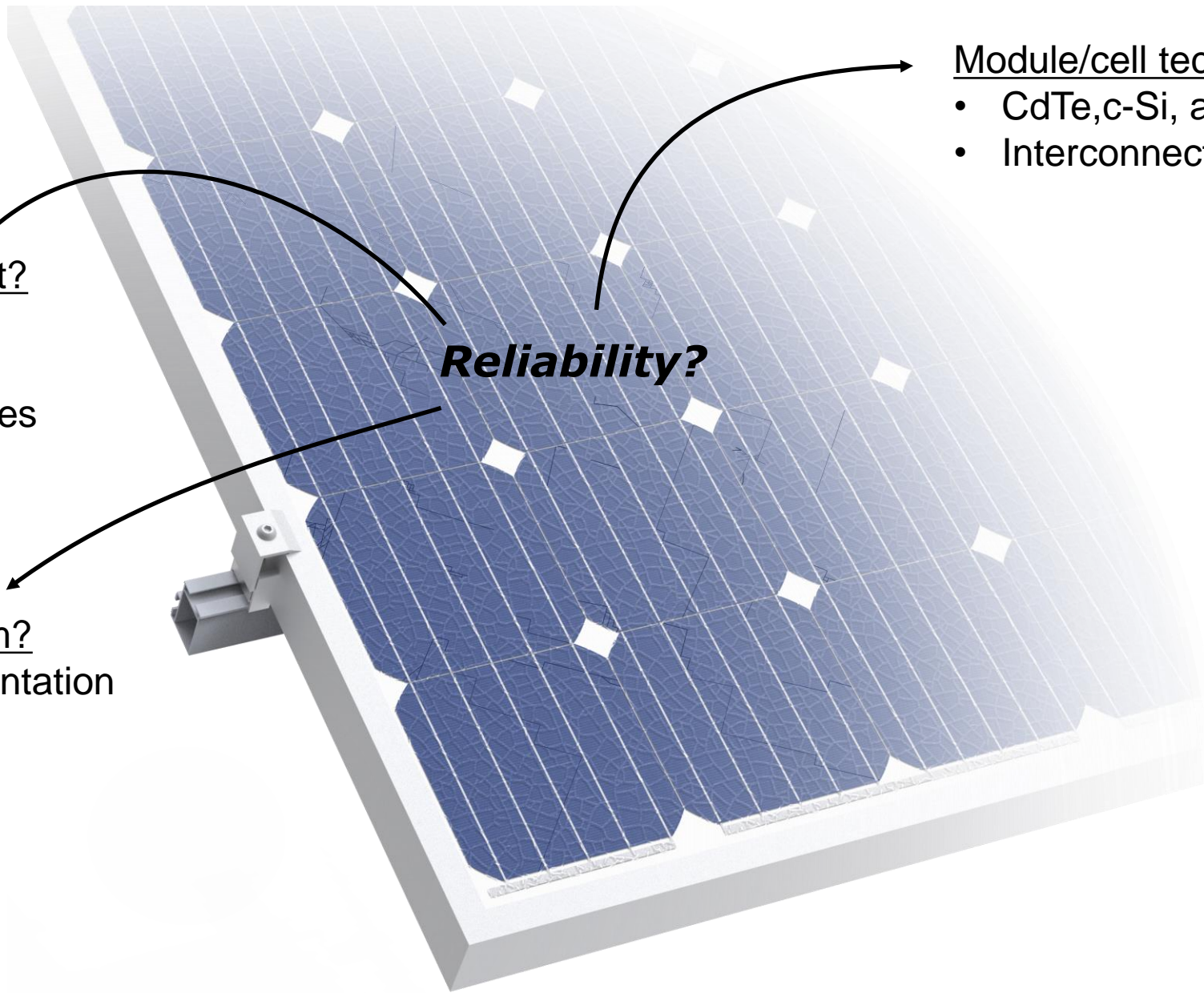
## System?

- Module orientation
- Clamping

## **Reliability?**

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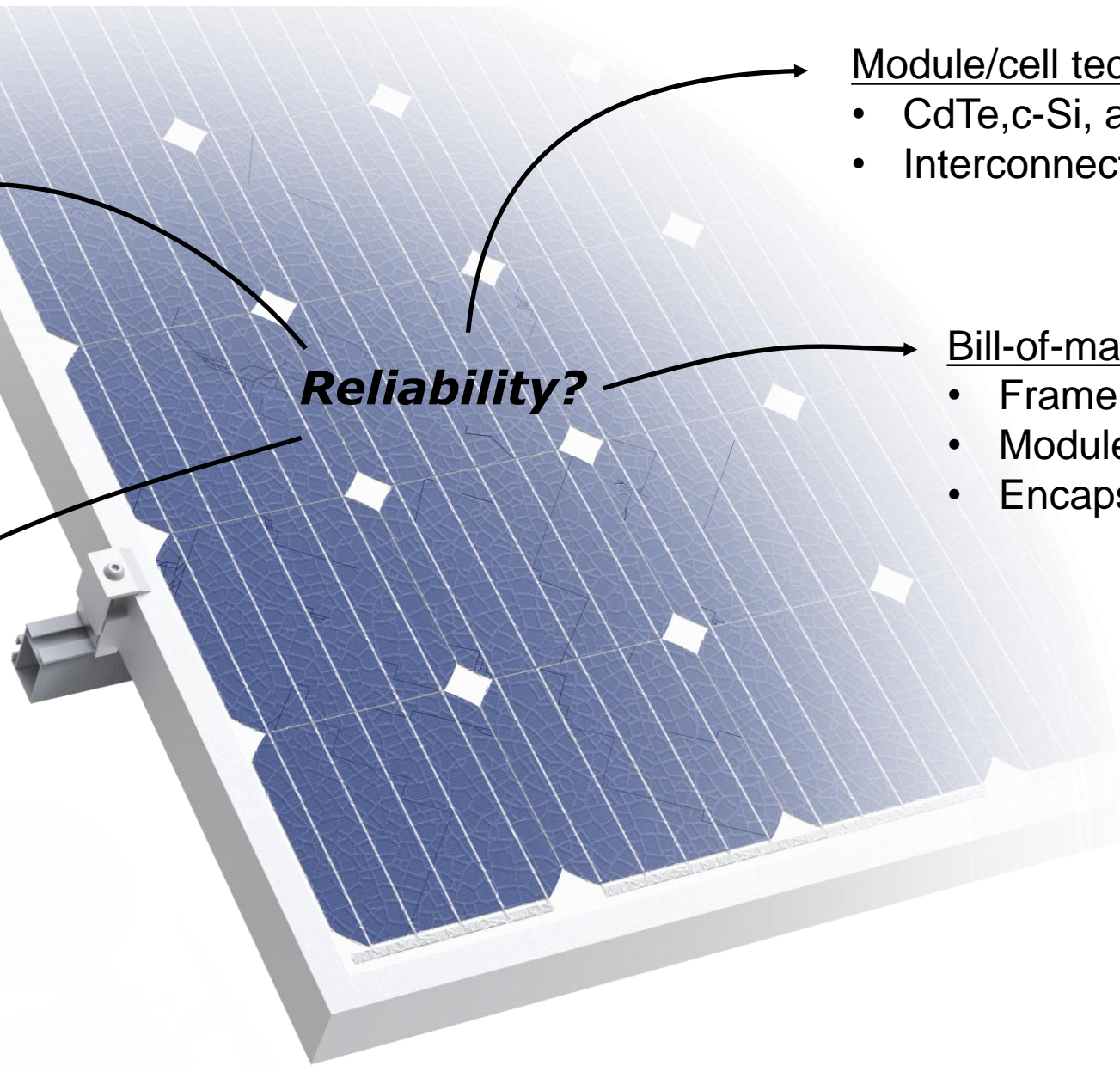
## **Reliability?**

## Module/cell technologies?

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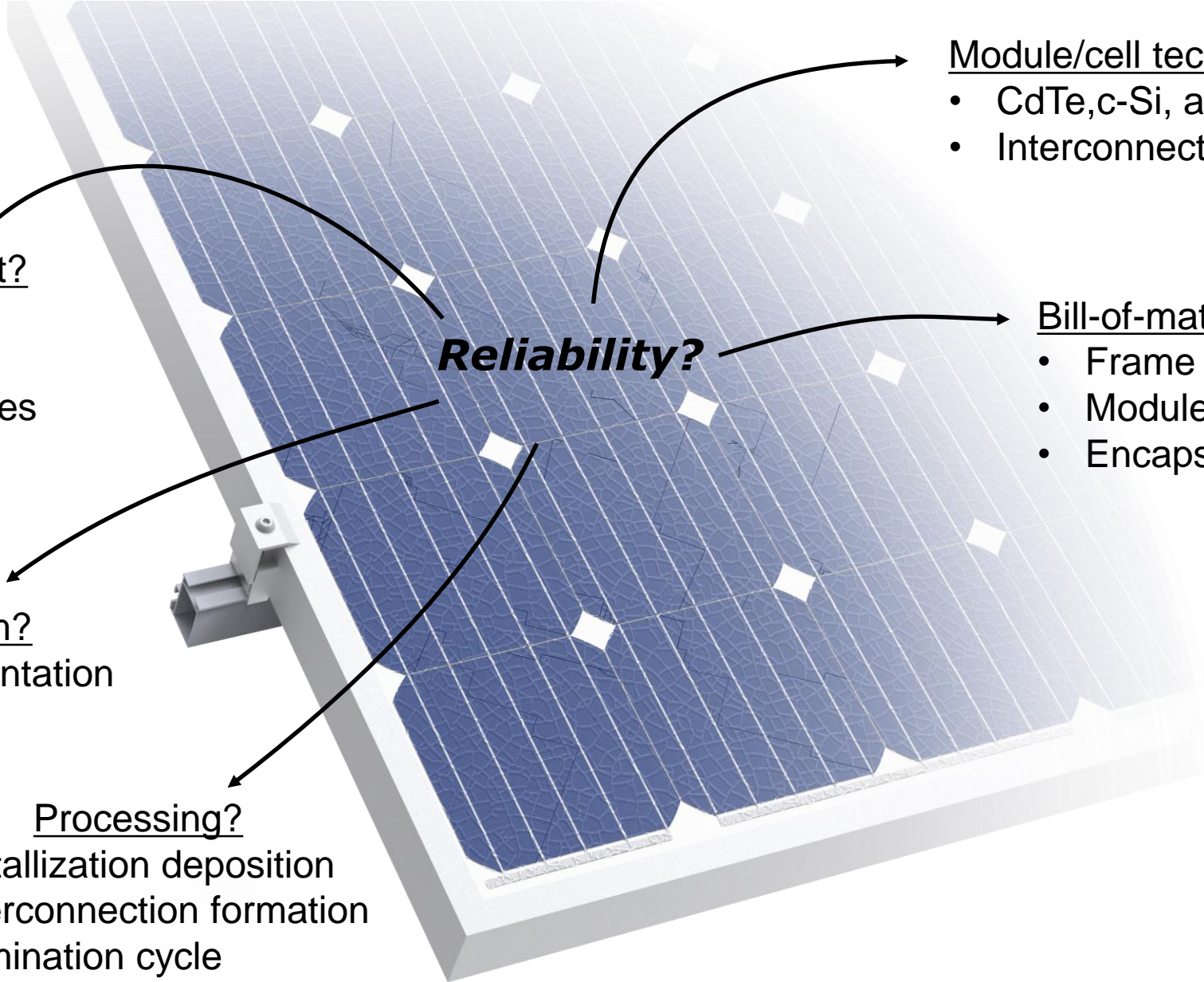
## Bill-of-materials/dimensions?

- Frame
- Module size
- Encapsulant material





# Motivation



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## System?

- Module orientation
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## Processing?

- Metallization deposition
- Interconnection formation
- Lamination cycle

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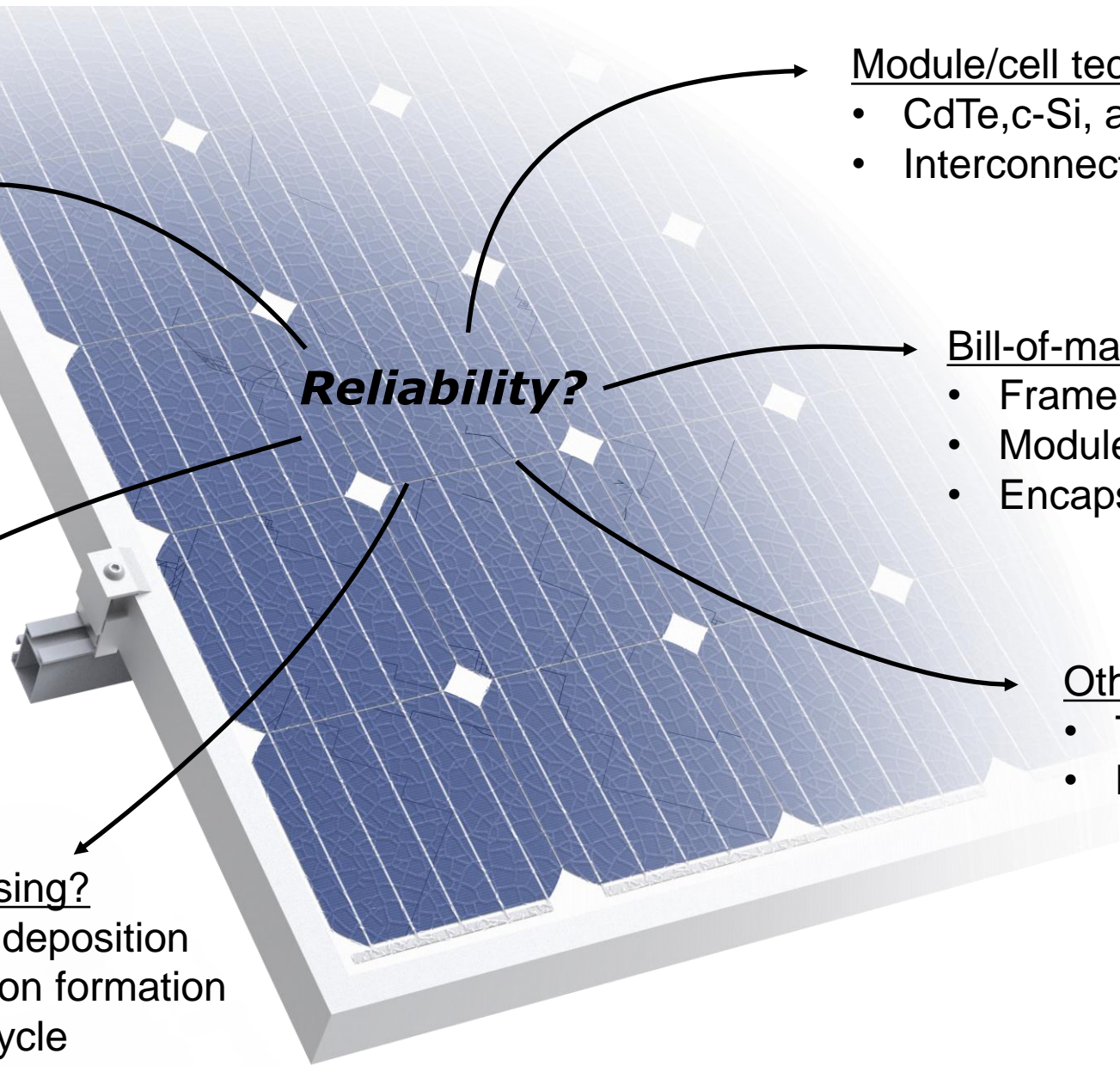
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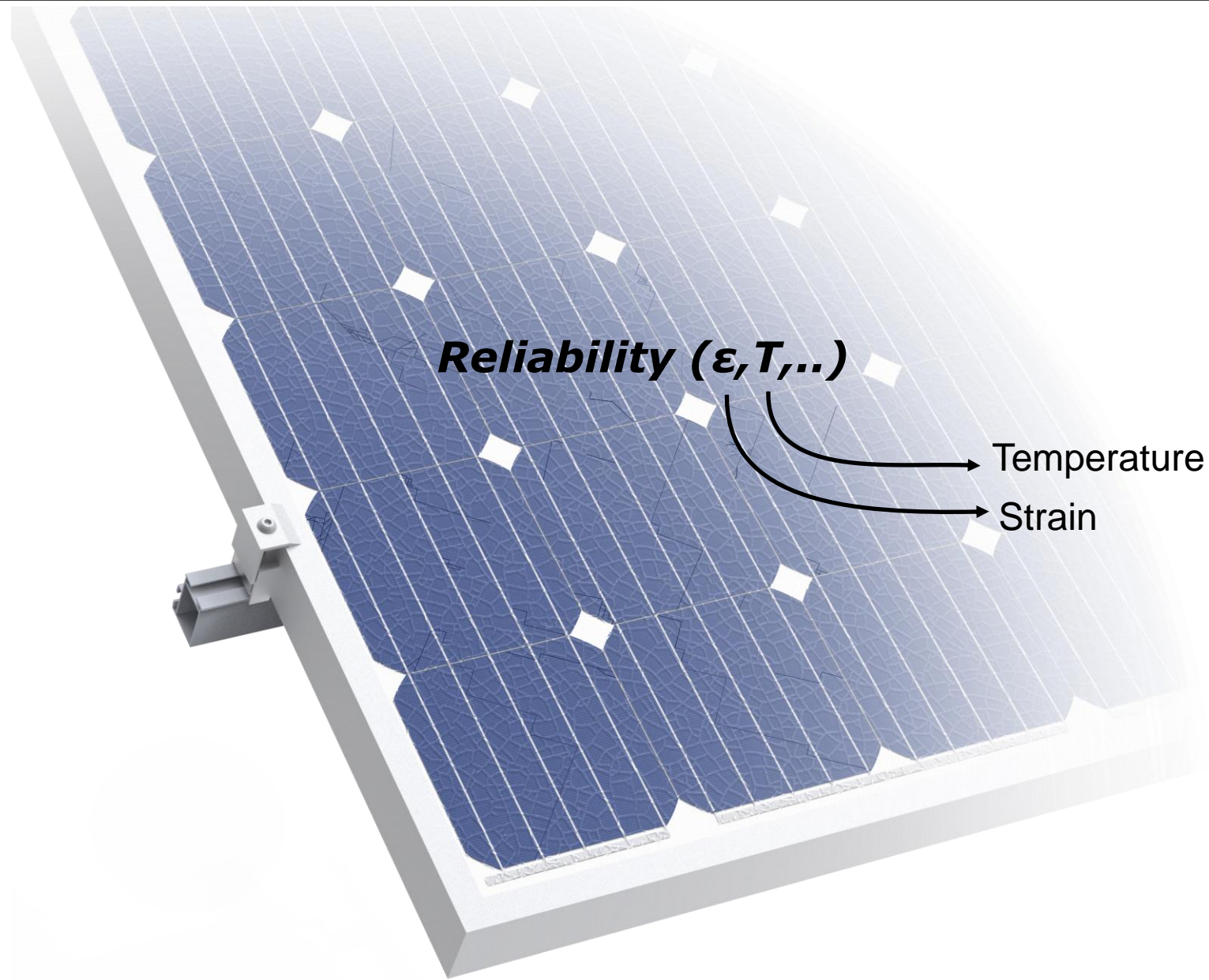
- Frame
- Module size
- Encapsulant material

## Others?

- Transport conditions
- Maintenance



# Motivation





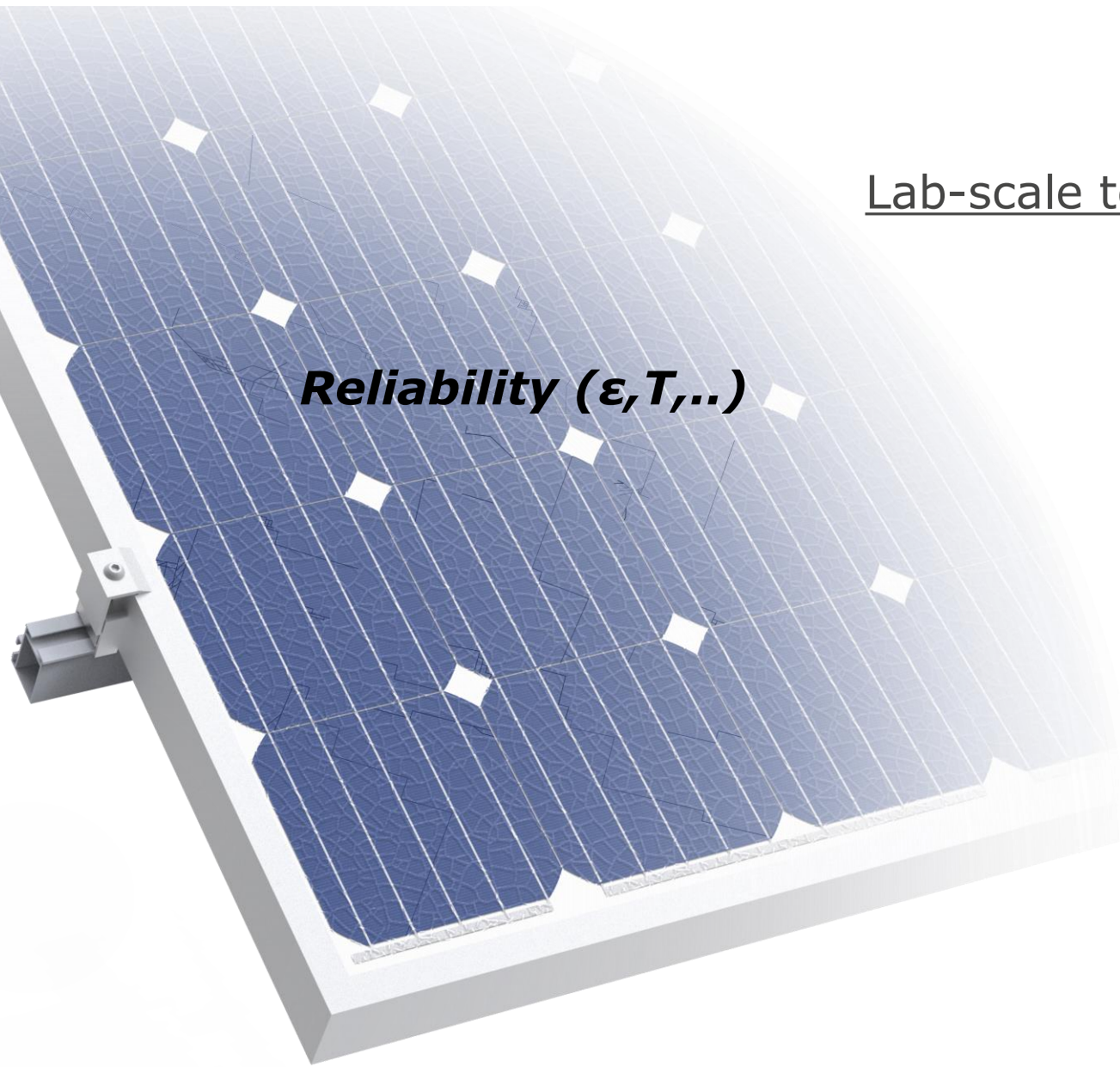
# Motivation

Field testing

Lab-scale testing

***Reliability ( $\epsilon, T, \dots$ )***

Accelerated stress testing



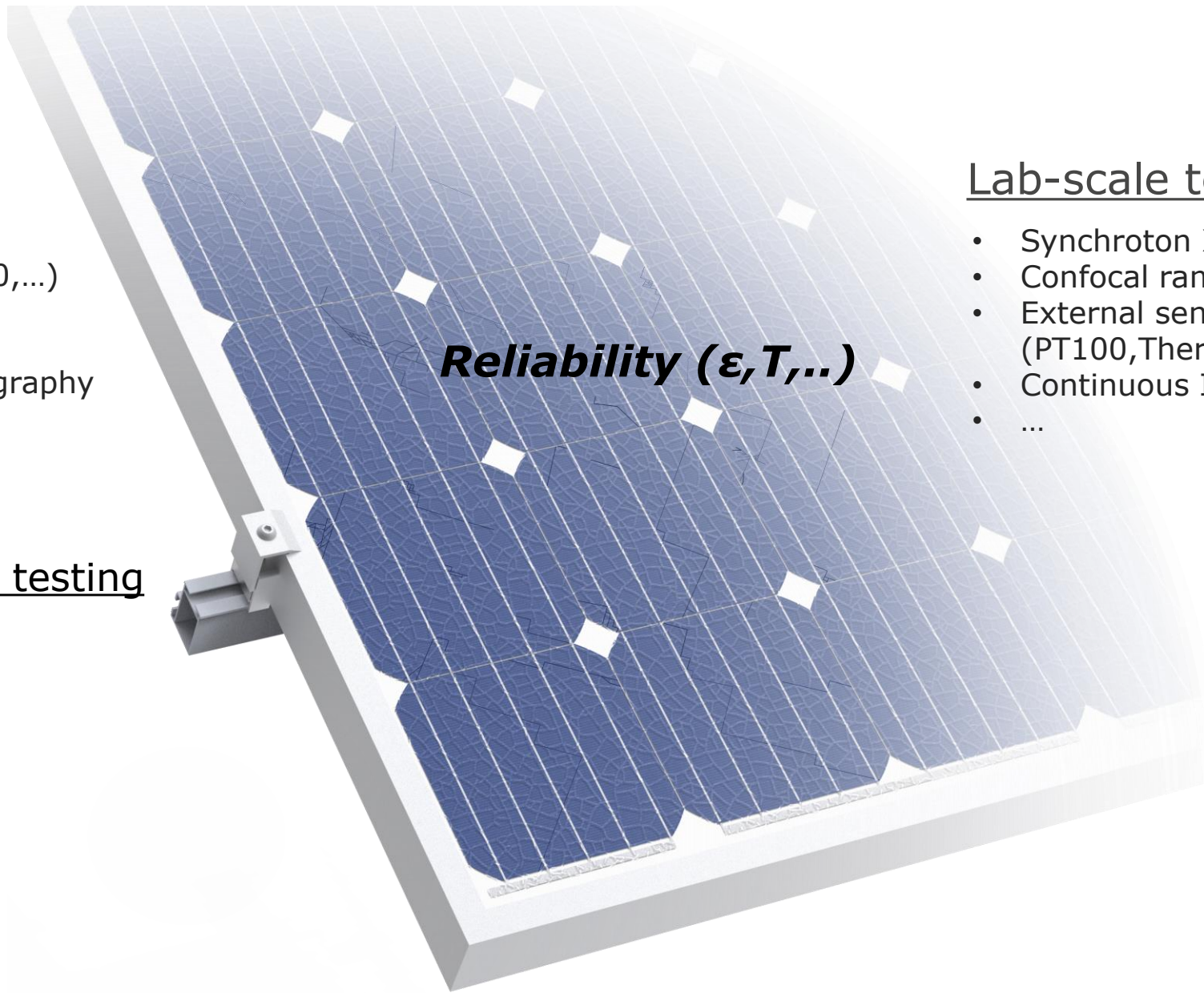
# Motivation

## Field testing

- External sensors (PT100,...)
- Intermittent I/V tracing
- Intermittent EL
- Intermittent IR thermography
- ...

## Accelerated stress testing

- Intermittent I/V tracing
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- Displacement sensors
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## Lab-scale testing

- Synchrotron X-ray microdiffraction
- Confocal raman microscopy
- External sensors (PT100, Thermocouple)
- Continuous IR thermography
- ...



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**Reliability ( $\epsilon, T, \dots$ )**

Physics based simulation

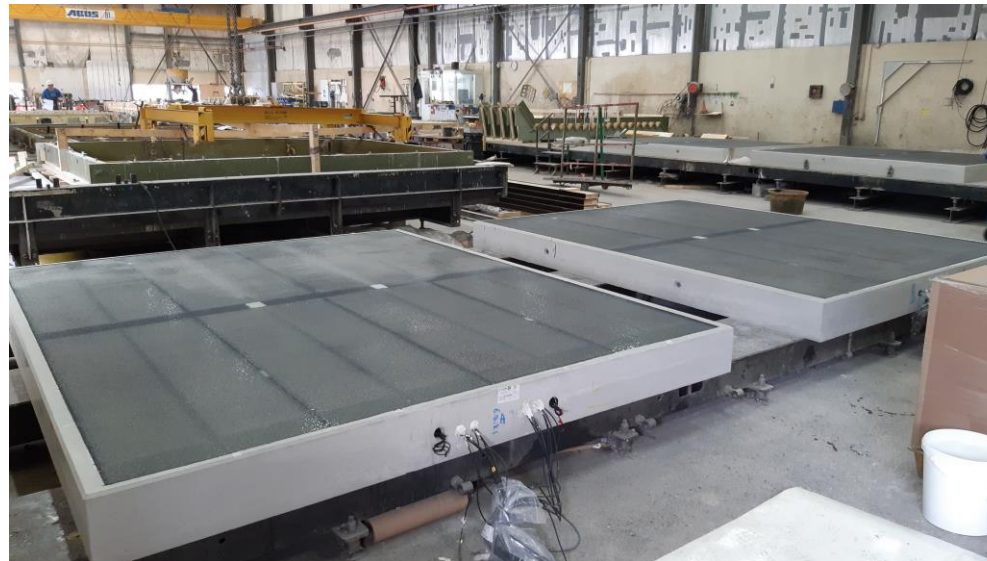
# Motivation



Building-integrated PV @  
Energyville site

***New applications pose additional challenges from a simulation and validation perspective***

- Commonly used assumptions from BA PV are not longer valid
- Use of new (laminate) materials/structures
- Increased interactions between the module and surrounding structures



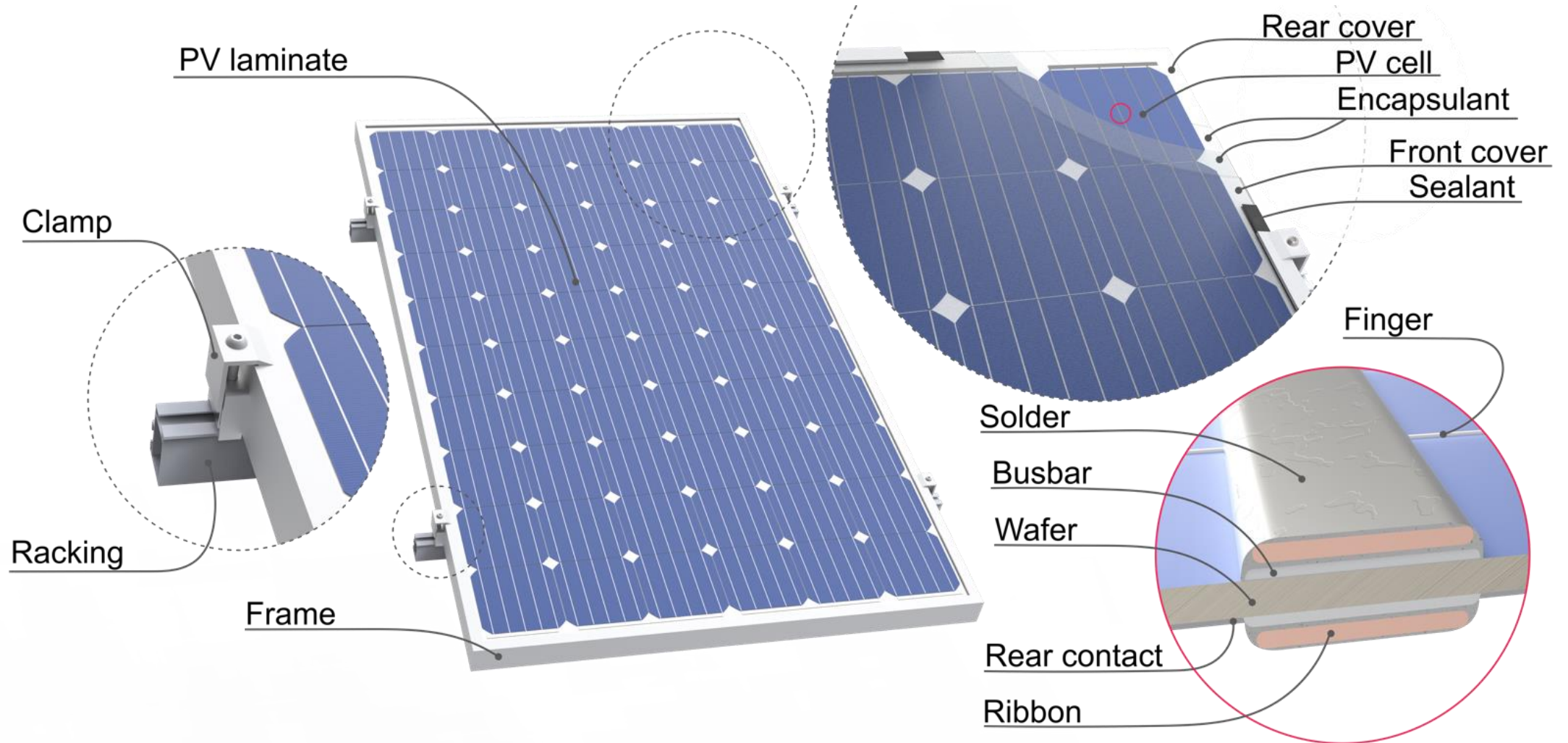
Road elements with integrated PV



Infrastructure-integrated PV  
@ Energyville site



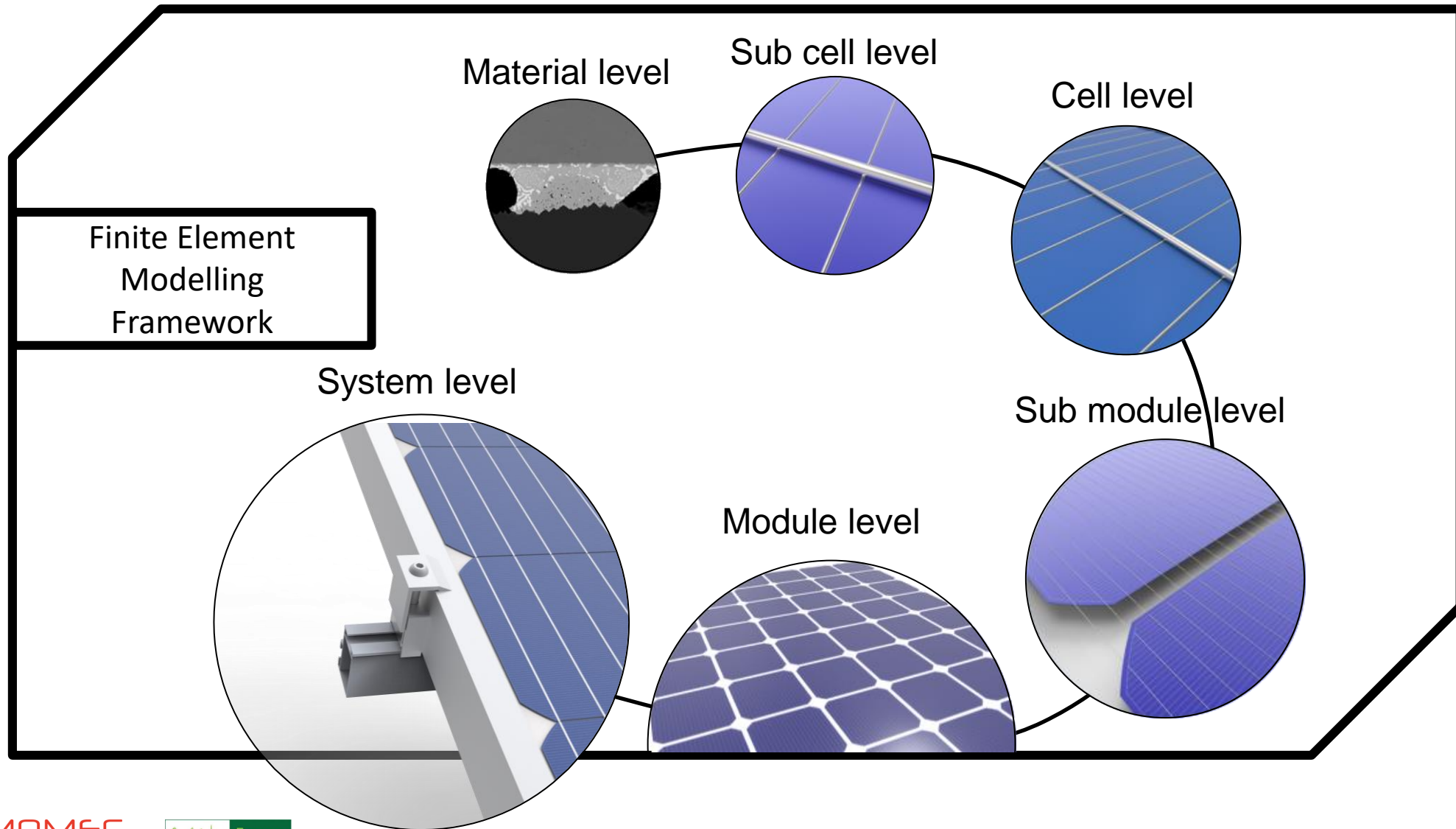
# Multi-scale nature of reliability



<sup>1</sup>An industry-standard PV module and all its constituents, reliability is largely determined by the scale regarded

# Multi-scale multi-physics reliability framework

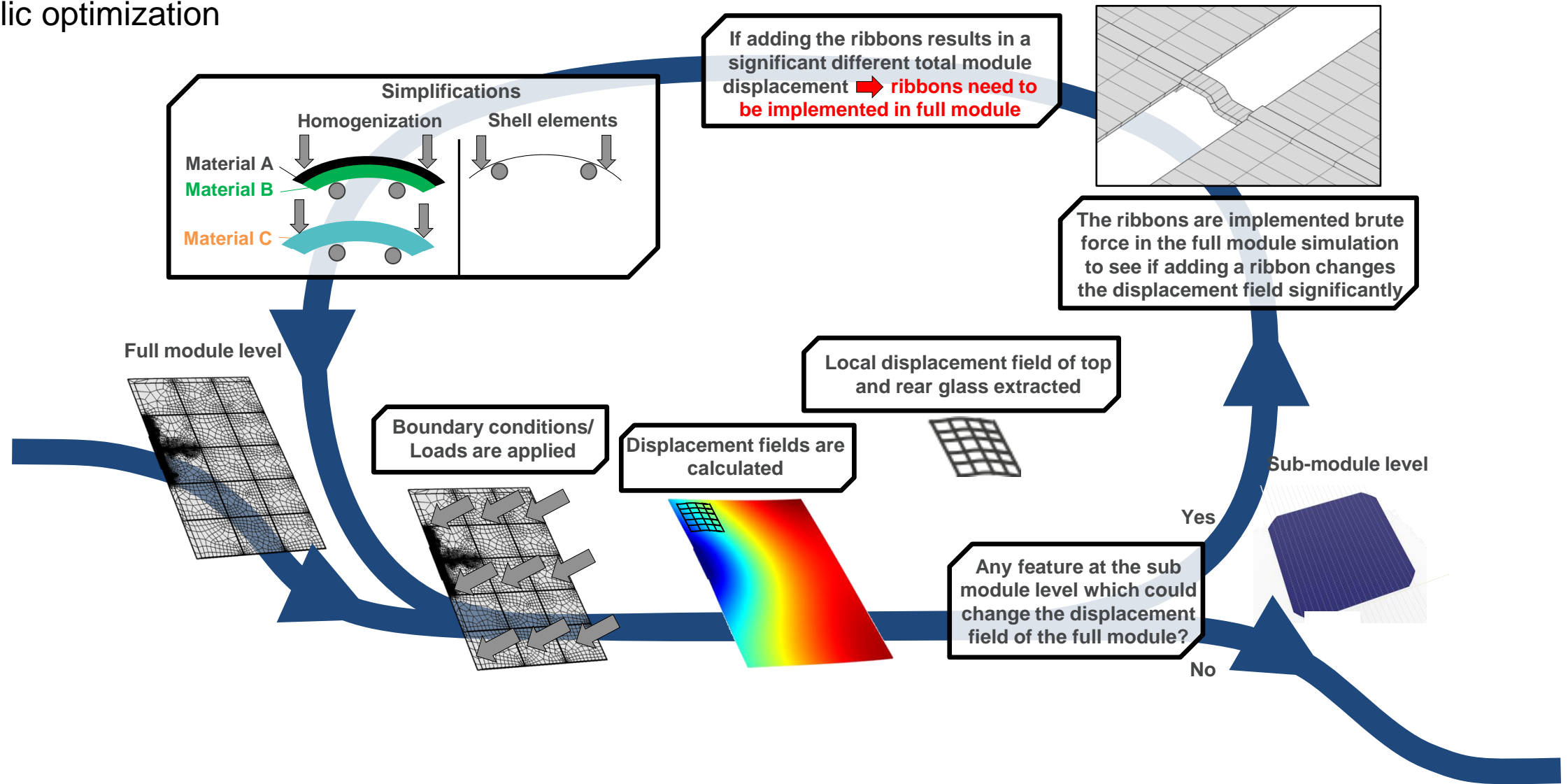
In submission\*





# Multi-scale multi-physics reliability framework

## Cyclic optimization

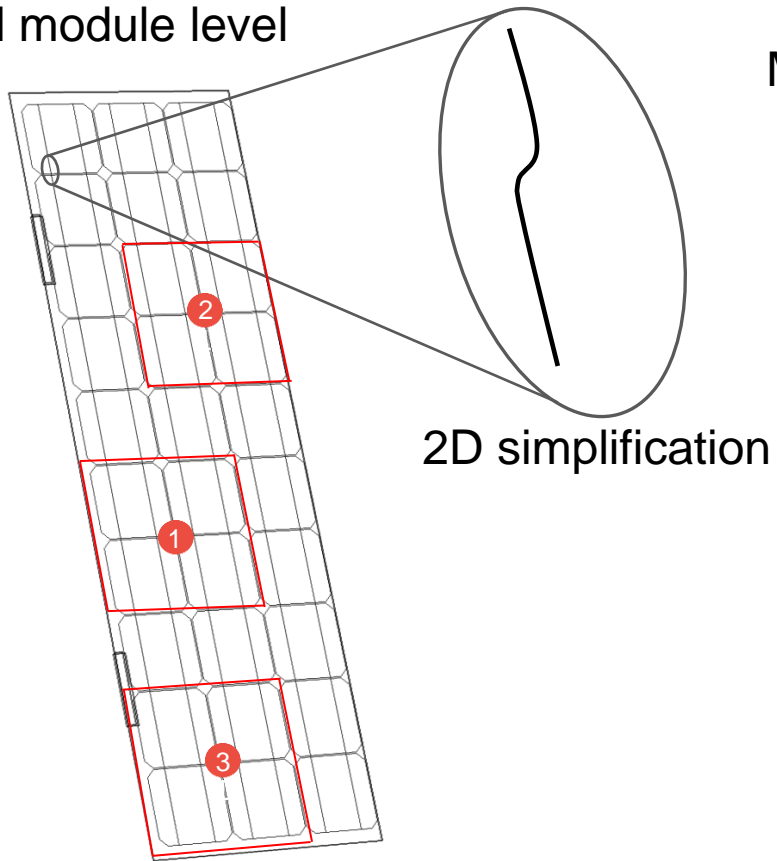


# Multi-scale multi-physics reliability framework

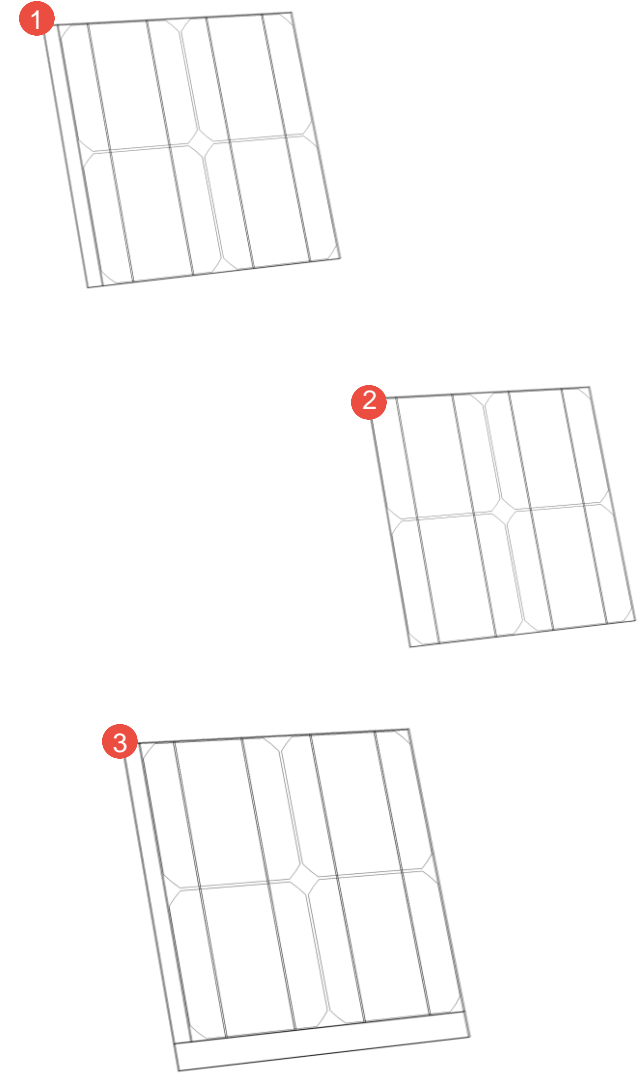
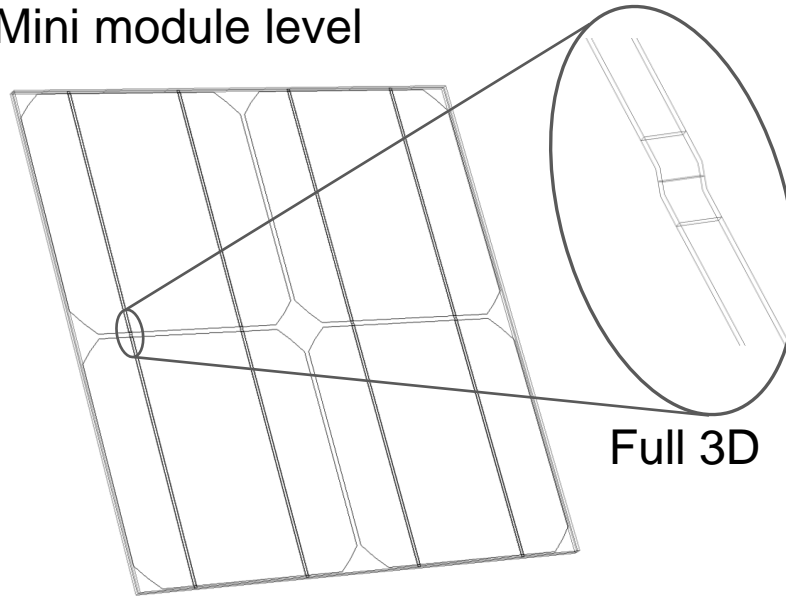
In submission\*

Multi-scale coupling – key features

Full module level



Mini module level

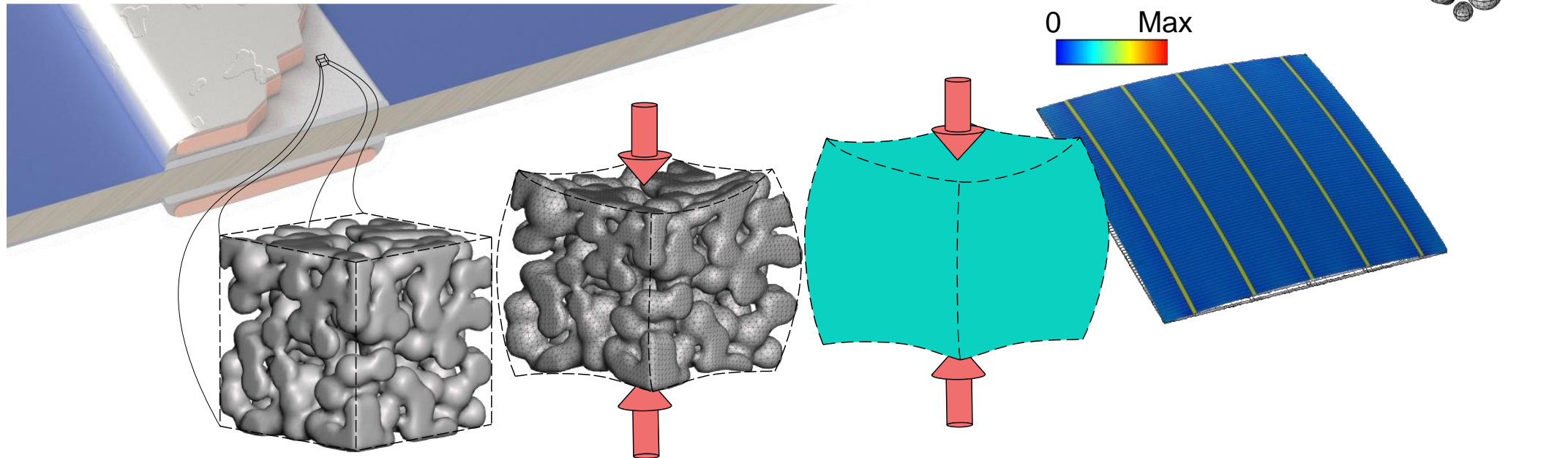




# Multi-scale multi-physics reliability framework

Material level

Material level



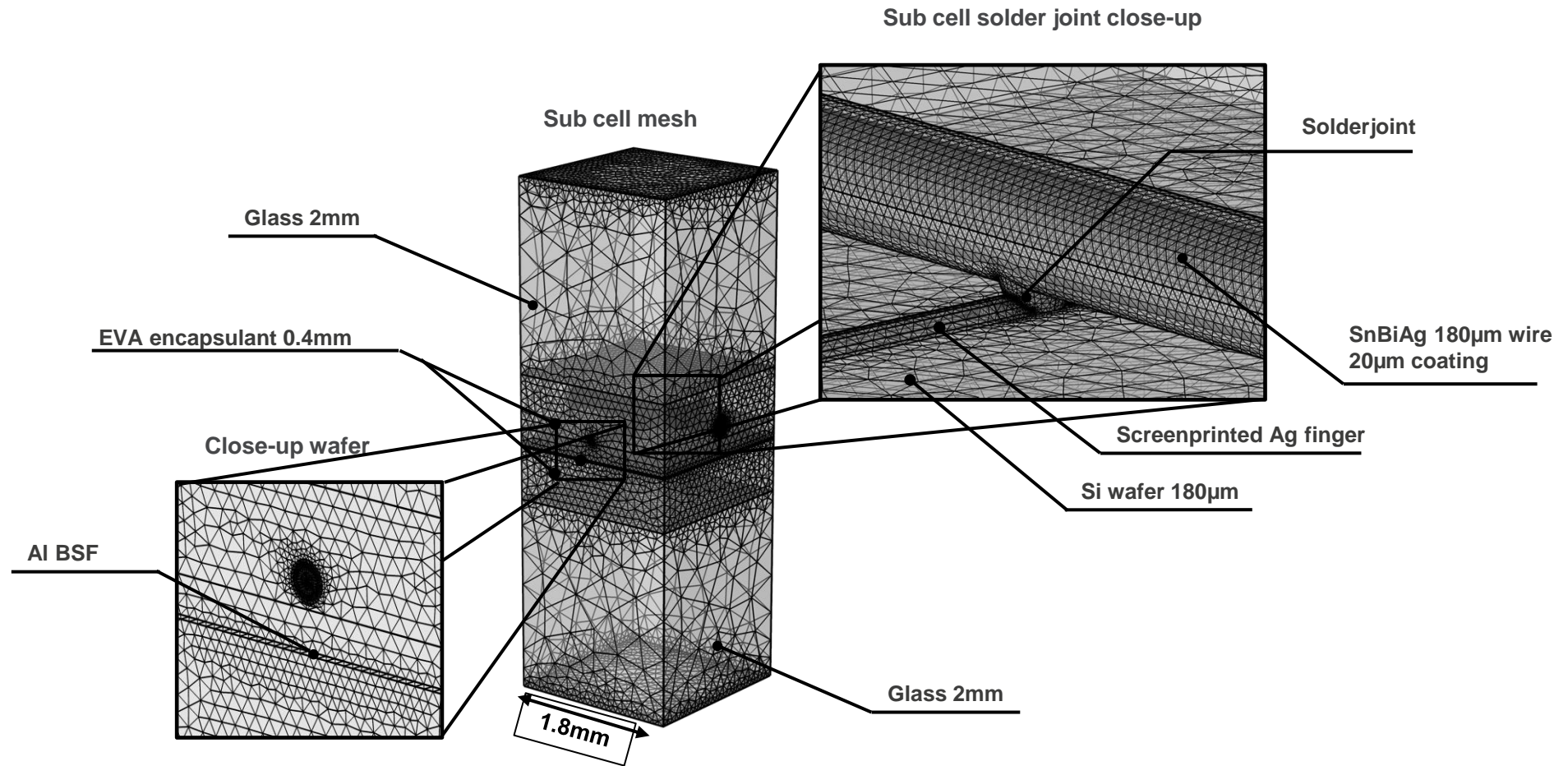
<sup>1</sup>Homogenization of complex materials such as Ag paste<sup>2</sup> or Solder alloys

<sup>1</sup>Figure adopted with permission from P. Nivellet et al - Stress and strain within photovoltaic modules using the finite element method: A critical review, Renewable sustainable energy reviews, 2021

<sup>2</sup> Van Amstel T, Popovich V, Bennett IJ. A multi-scale model for the aluminium layer at the rear side of a solar cell. Eur. Photovolt. Sol. Energy Conf. Exhib. 2009: 21–5.

# Multi-scale multi-physics reliability framework

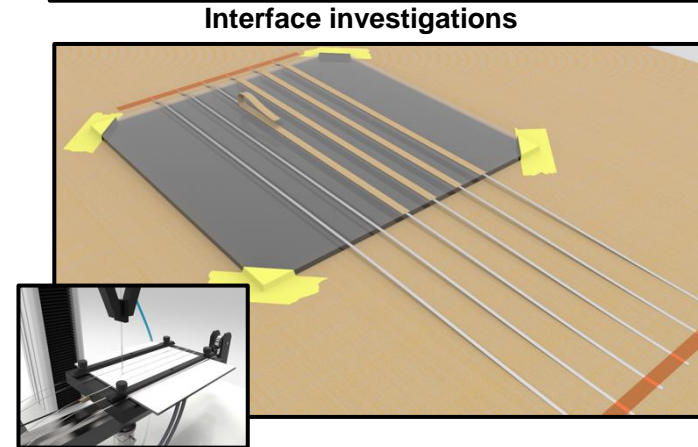
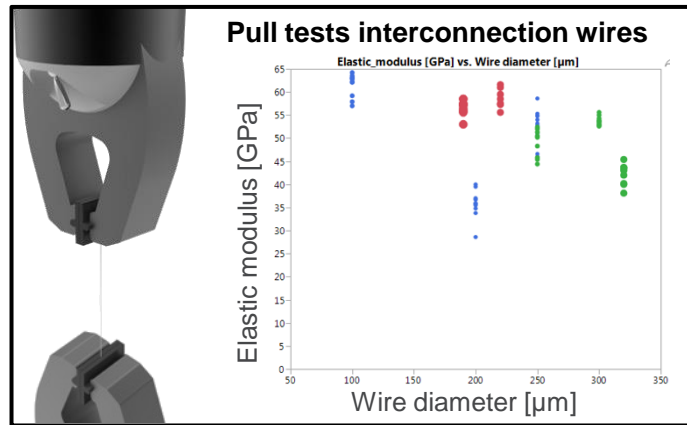
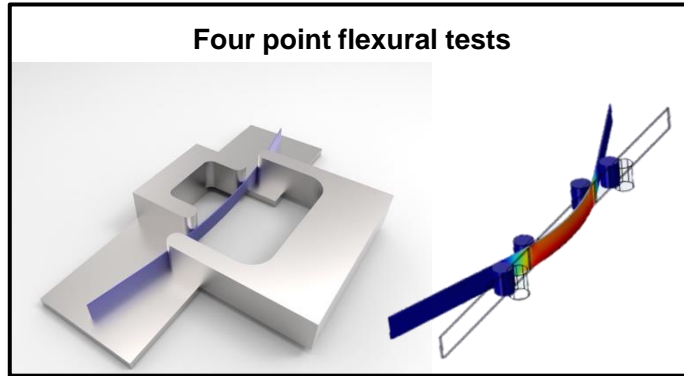
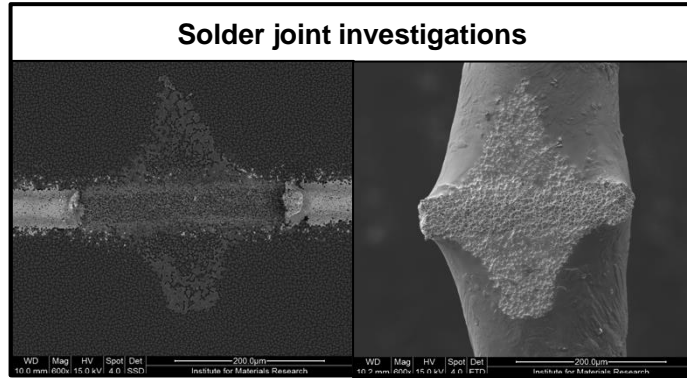
Sub-cell level





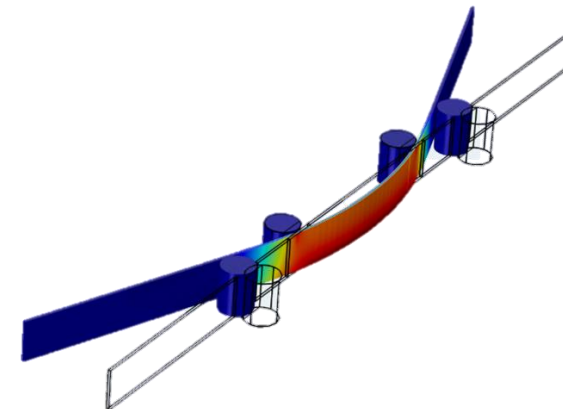
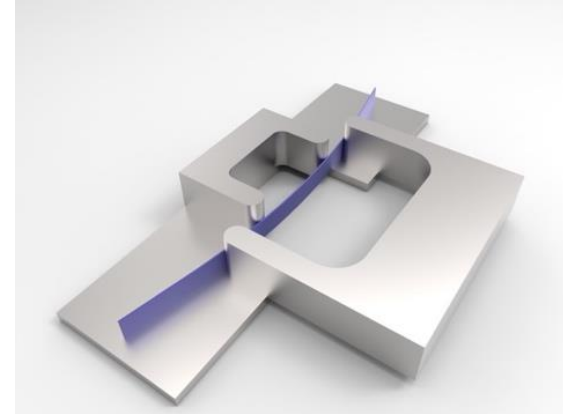
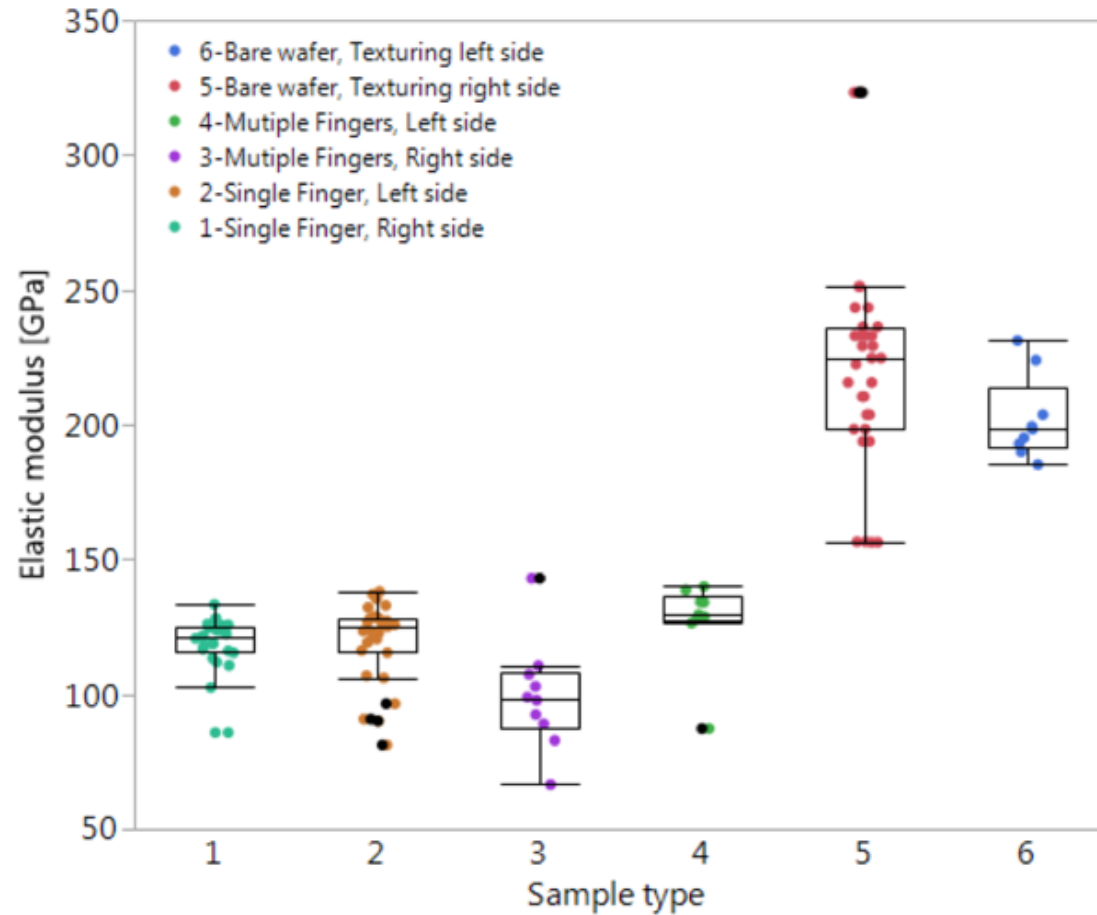
# Multi-scale multi-physics reliability framework

Characterization as input



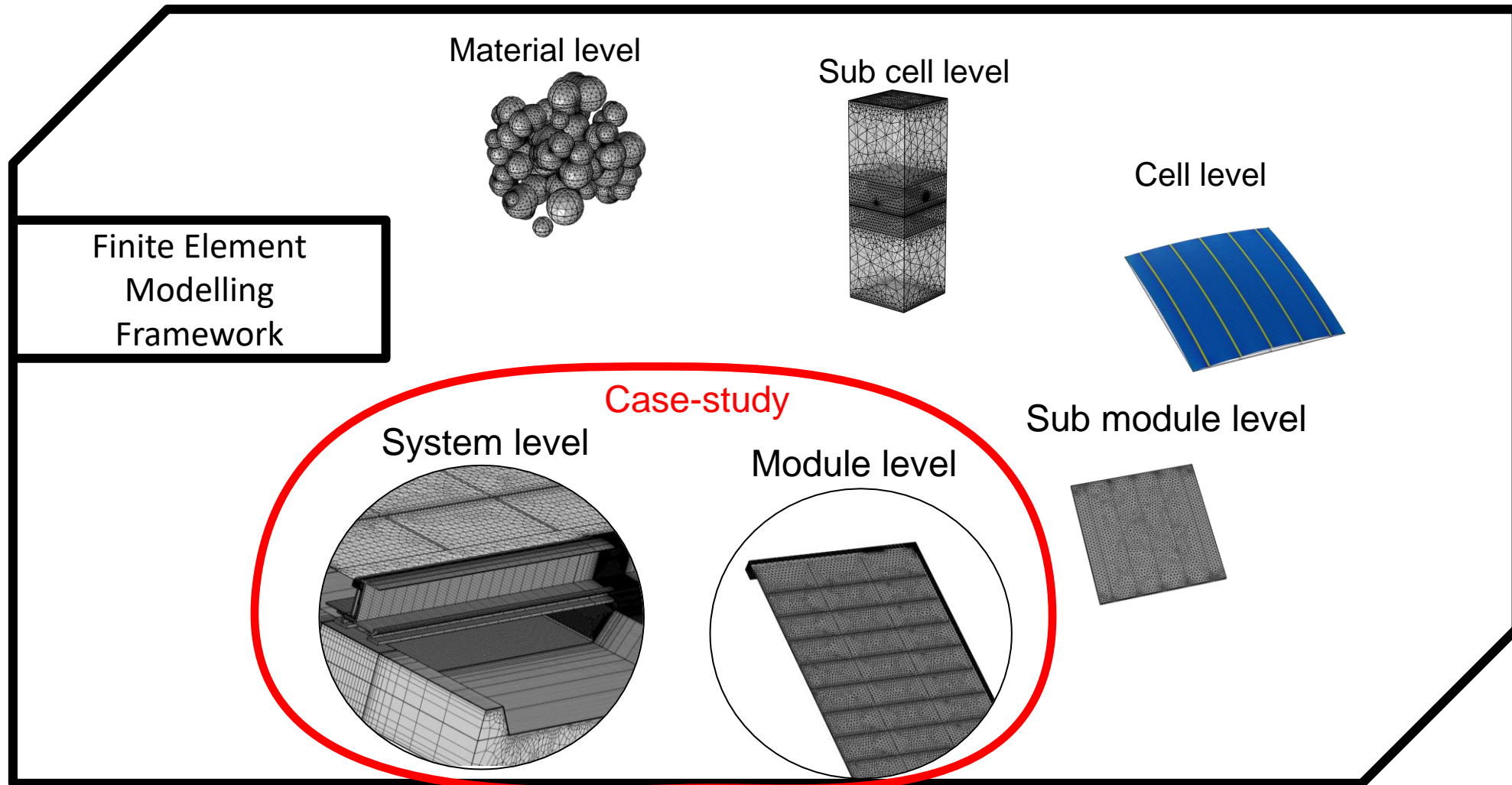
# Multi-scale multi-physics reliability framework

Abstraction method for various levels determined through characterization





# Multi-scale multi-physics reliability framework



# Multi-scale multi-physics reliability framework

In submission\*

A case study on how roofing and mounting affects module behaviour



Mounting system for corrugated rooftiles



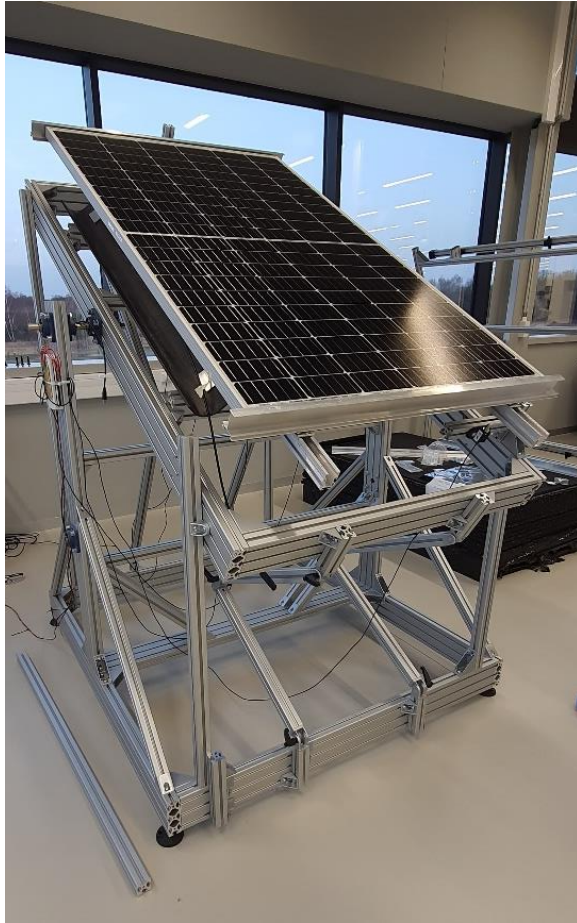
Mounting system for steeldeck rooftiles



# A case study

In submission\*

Mechanical deformation testing using custom mechanical test setup



Single module system built on mechanical stress tester



Mechanical load performed test at 30° angle



Contactless displacement sensors mounted on framing and modules

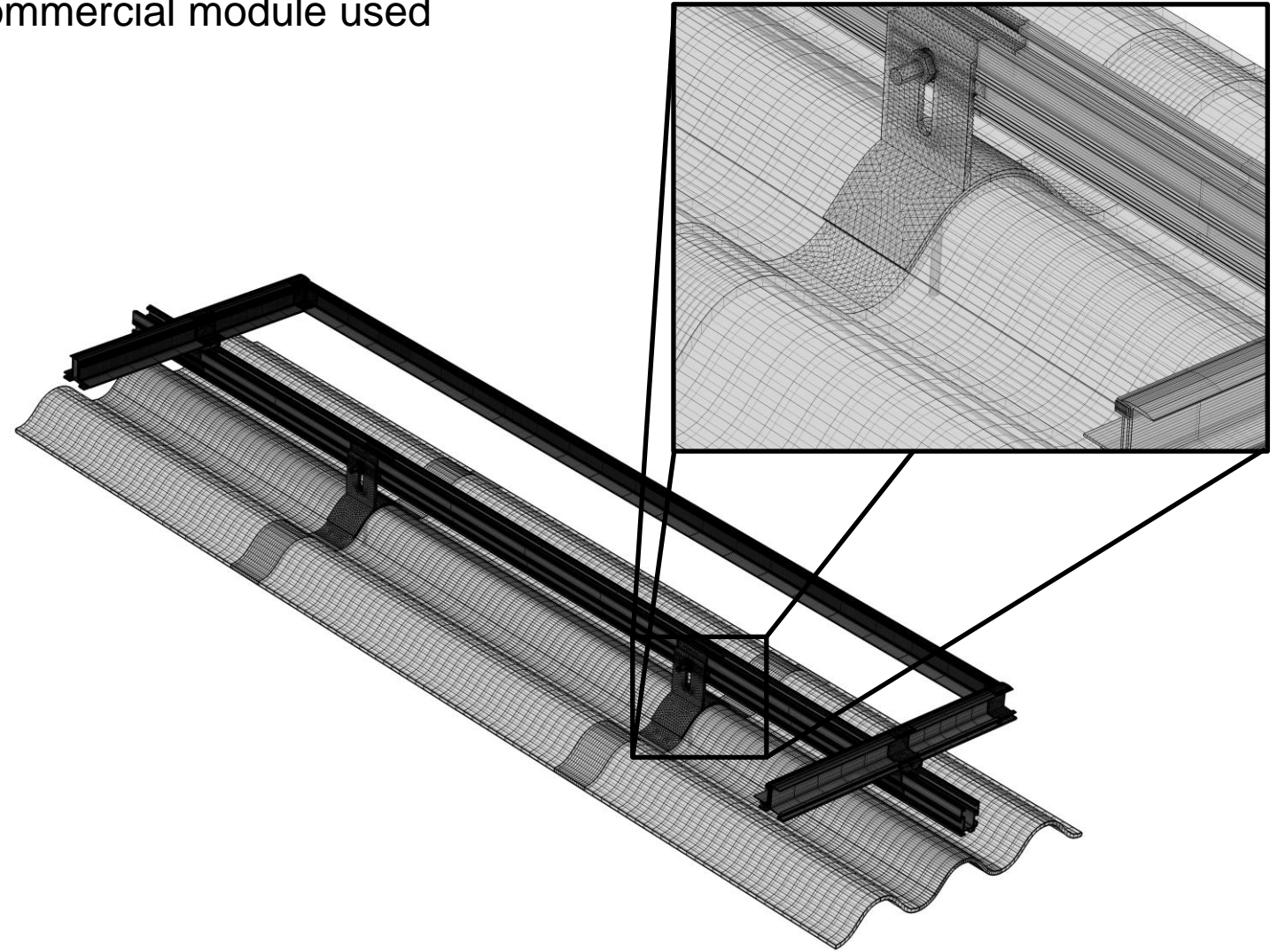
# A case study

In submission\*

Calibrating module level simulation due to commercial module used



Calibrating module model (ran about 3k variations)

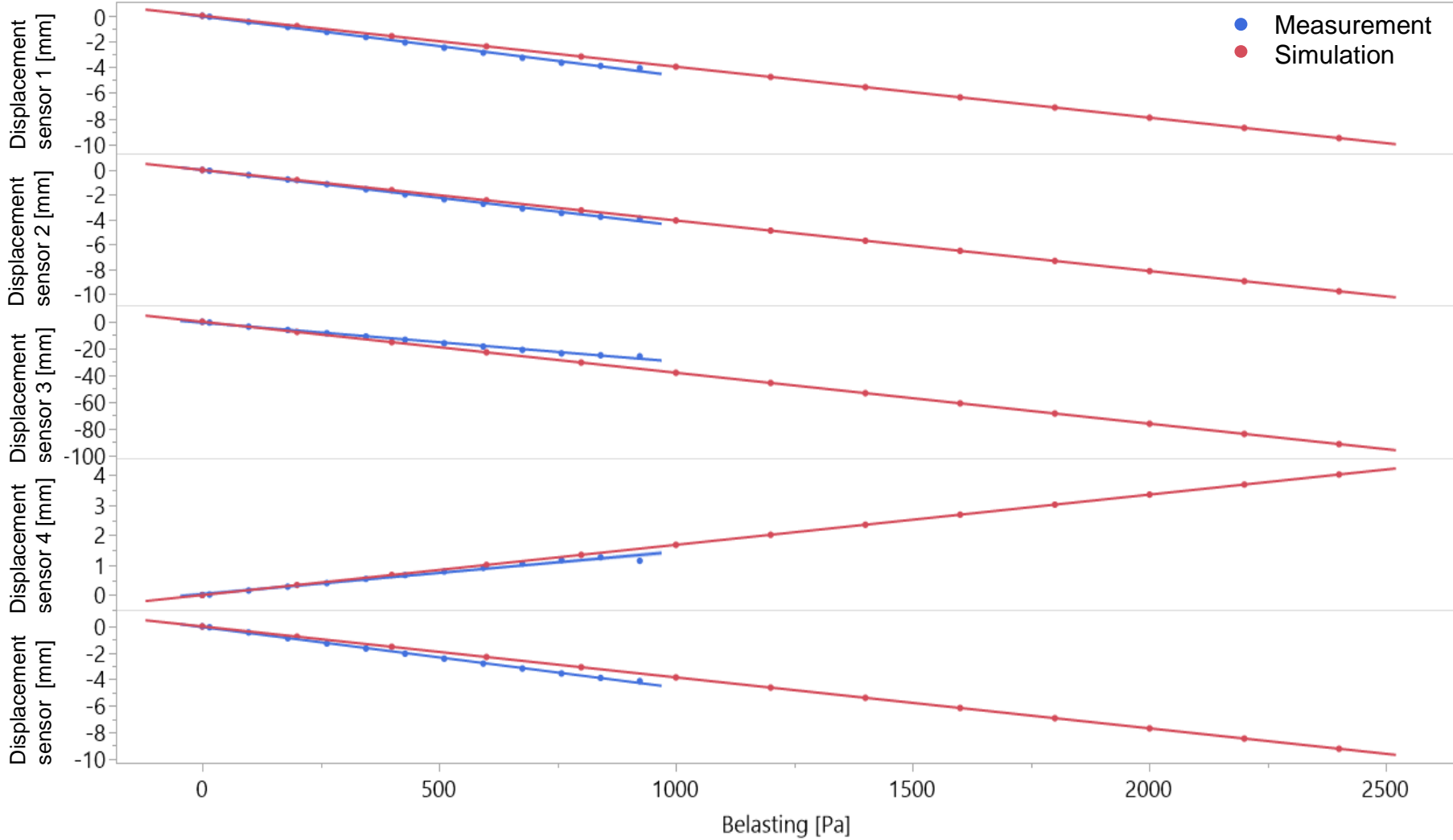


Creating system level model

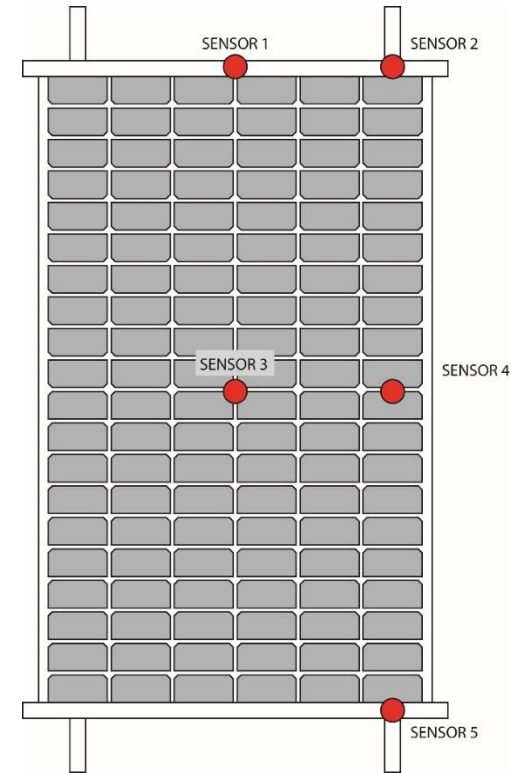
# A case study

In submission\*

## Validation using system and module deformation



Sensor layout top view

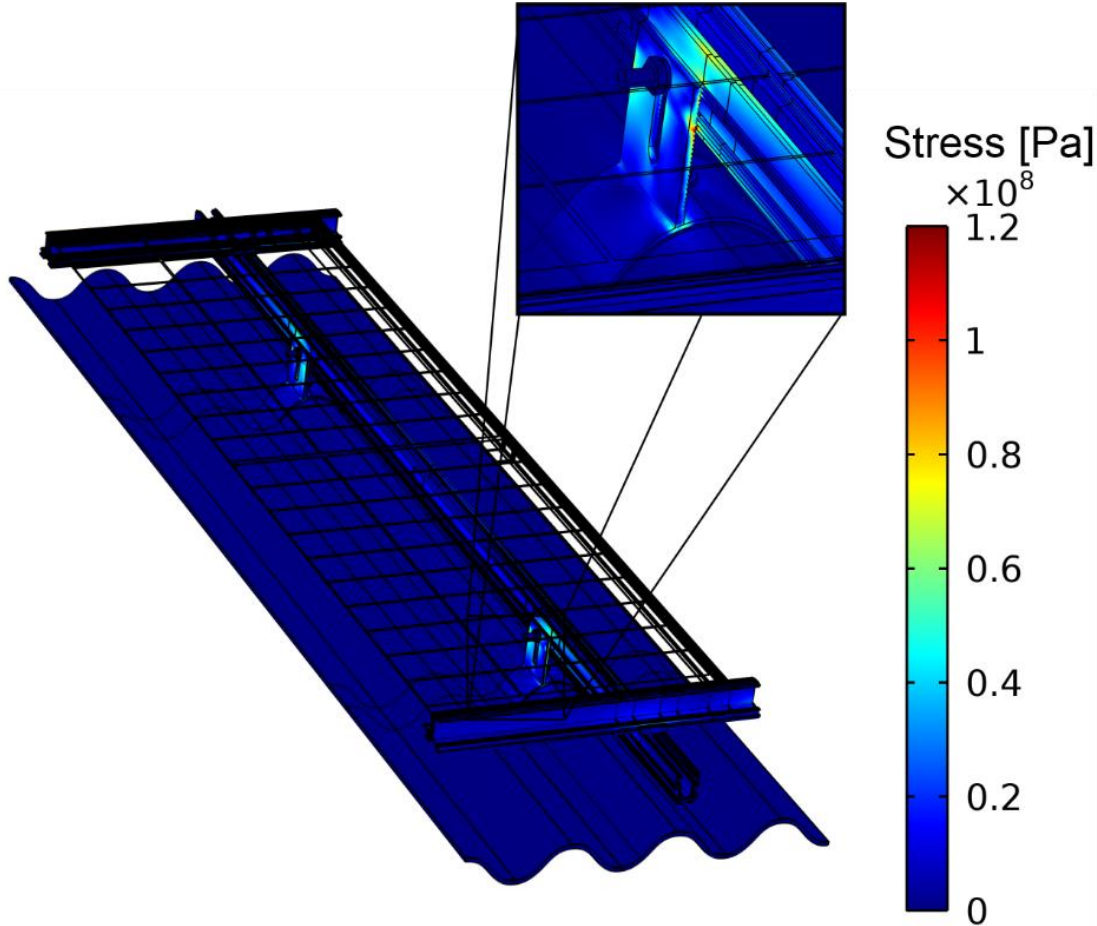




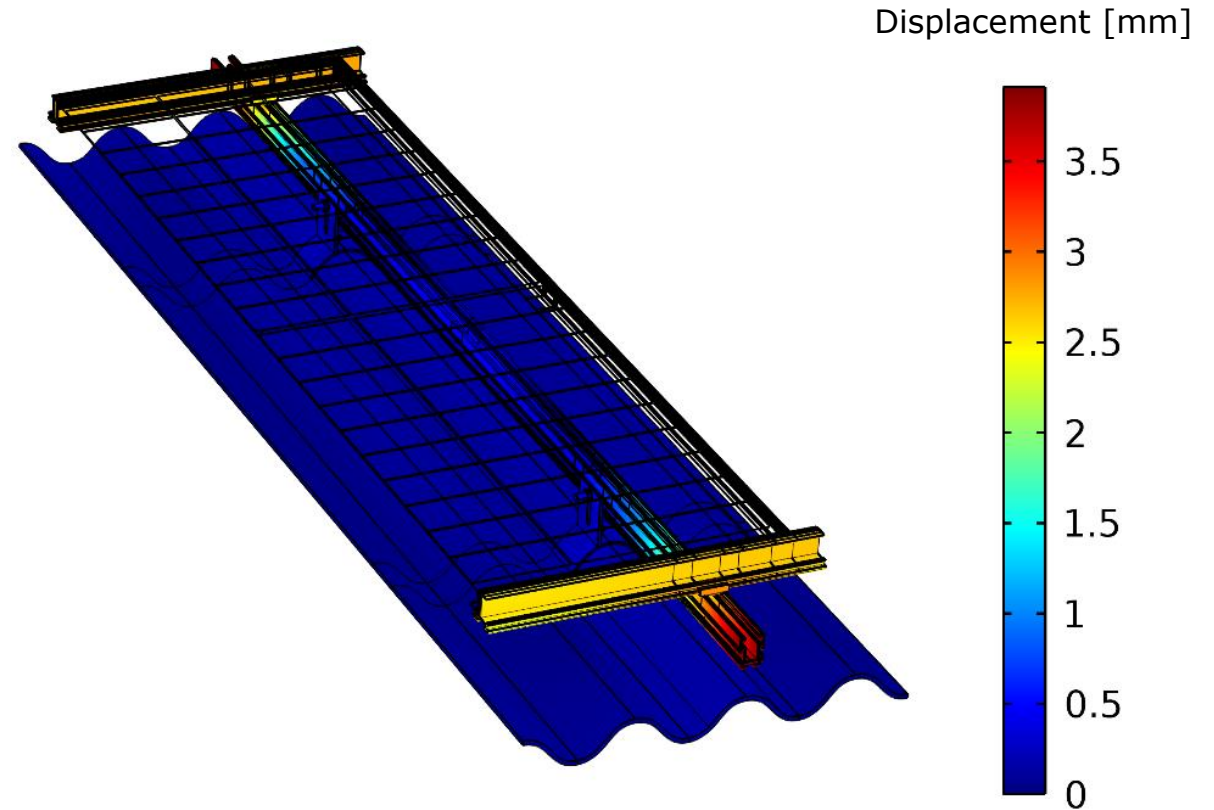
# A case study

Simulation results

In submission\*



Stress-concentrations near roofclamp at a load of 1000 Pa with critical zones identified



Displacement of racking structure at 1000 Pa homogeneous load

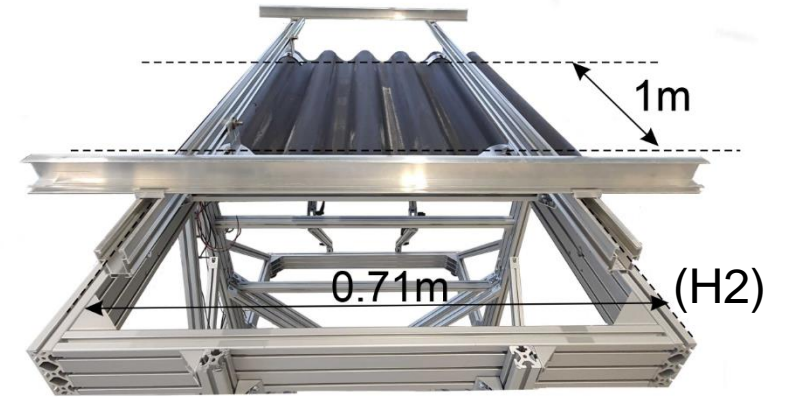
# A case study

In submission\*

Value for industry

H2 713 mm		Load [Pa]													
		400	600	800	1000	1200	1400	1600	1800	2000	2200	2400	2600	2800	3000
Mounting angle [°]	0	31%	44%	56%	68%	81%	93%	105%	117%	130%	142%	154%	166%	179%	191%
	5	31%	43%	55%	68%	80%	92%	104%	116%	128%	140%	153%	165%	177%	189%
	10	31%	42%	54%	66%	78%	90%	102%	114%	126%	138%	150%	162%	174%	185%
	15	30%	41%	53%	65%	76%	88%	99%	111%	123%	134%	146%	157%	169%	181%
	20	29%	40%	51%	62%	74%	85%	96%	107%	118%	130%	141%	152%	163%	174%
	25	27%	38%	49%	60%	70%	81%	92%	102%	113%	124%	135%	145%	156%	167%
	30	27%	38%	48%	59%	69%	79%	90%	100%	111%	121%	131%	142%	152%	163%

H2 1068 mm		Load [Pa]													
		400	600	800	1000	1200	1400	1600	1800	2000	2200	2400	2600	2800	3000
Mounting angle [°]	0	37%	52%	66%	81%	95%	110%	124%	138%	153%	167%	182%	196%	211%	225%
	5	37%	51%	65%	80%	94%	108%	123%	137%	151%	166%	180%	194%	209%	223%
	10	36%	50%	64%	78%	92%	106%	120%	134%	149%	163%	177%	191%	205%	219%
	15	35%	49%	63%	76%	90%	104%	117%	131%	145%	158%	172%	186%	199%	213%
	20	34%	47%	60%	74%	87%	100%	113%	126%	140%	153%	166%	179%	193%	206%
	25	32%	45%	58%	70%	83%	96%	108%	121%	134%	146%	159%	172%	184%	197%
	30	31%	43%	55%	67%	79%	91%	103%	115%	127%	139%	151%	162%	174%	186%



# Indirect validation

## Field testing

- External sensors (PT100,...)
- Intermittent I/V tracing
- Intermittent EL
- Intermittent IR thermography
- ...

## Accelerated stress testing

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## Lab-scale testing

- Synchrotron X-ray microdiffraction
- Confocal raman microscopy
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**Reliability ( $\epsilon, T, \dots$ )**

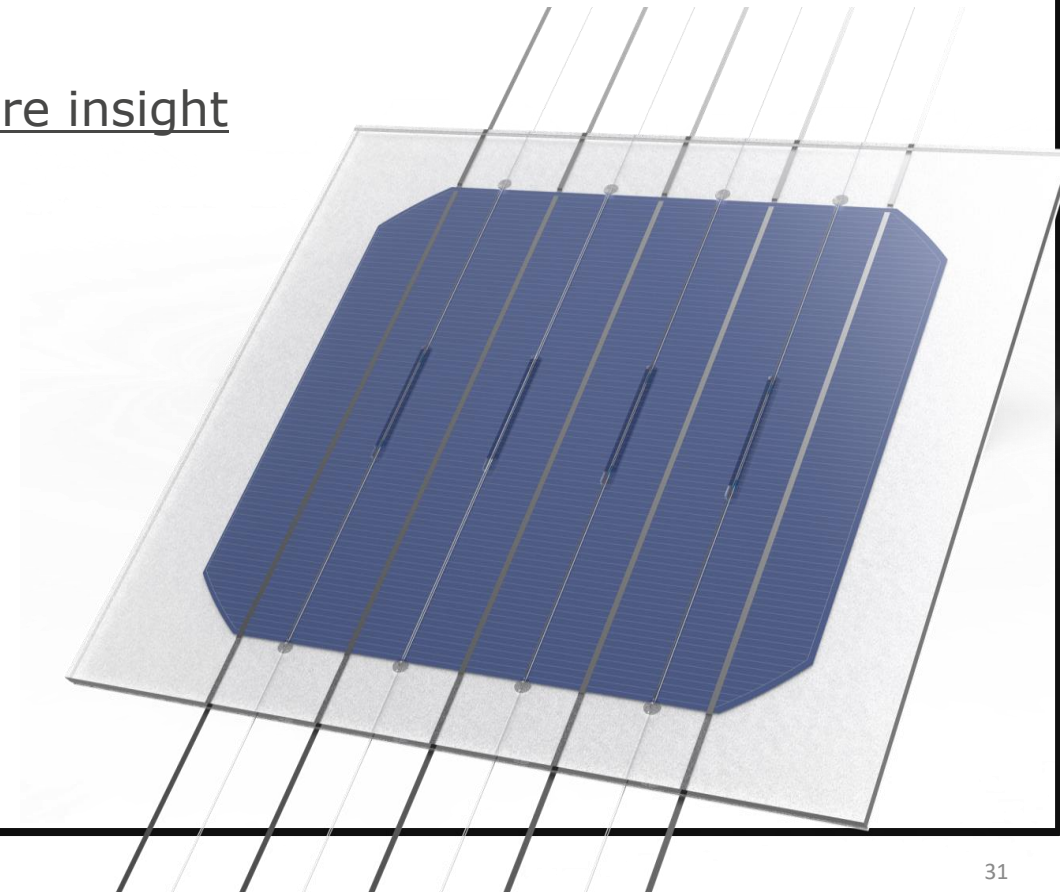
Physics based simulation



# Optical in-situ thermo-mechanical sensing solution

PV-sense<sup>2</sup>

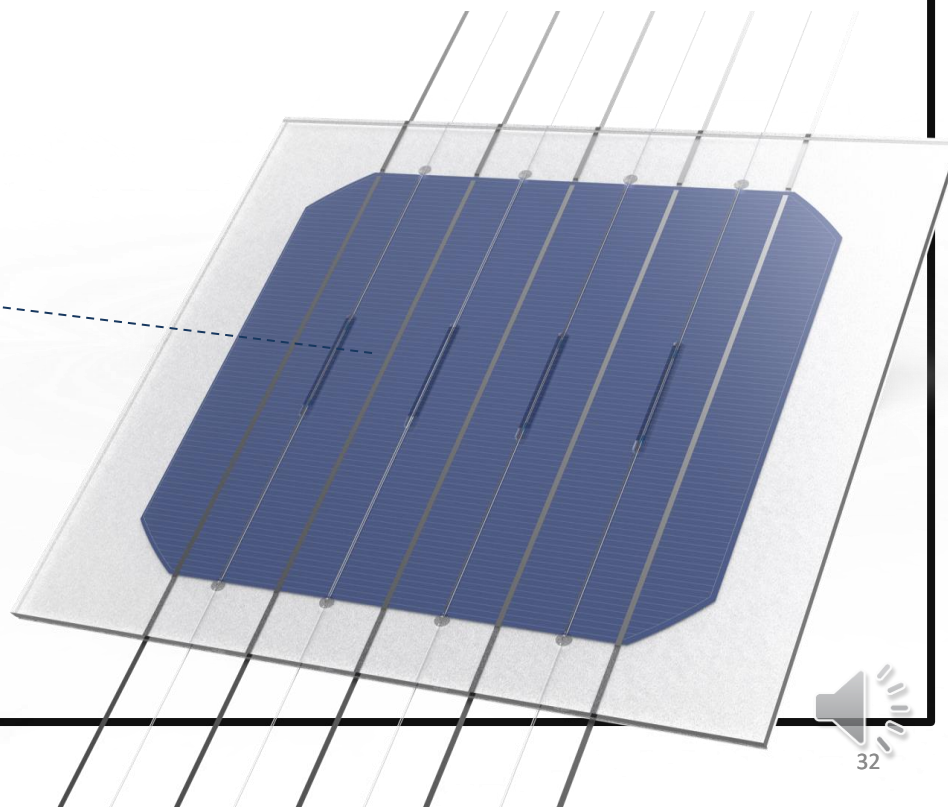
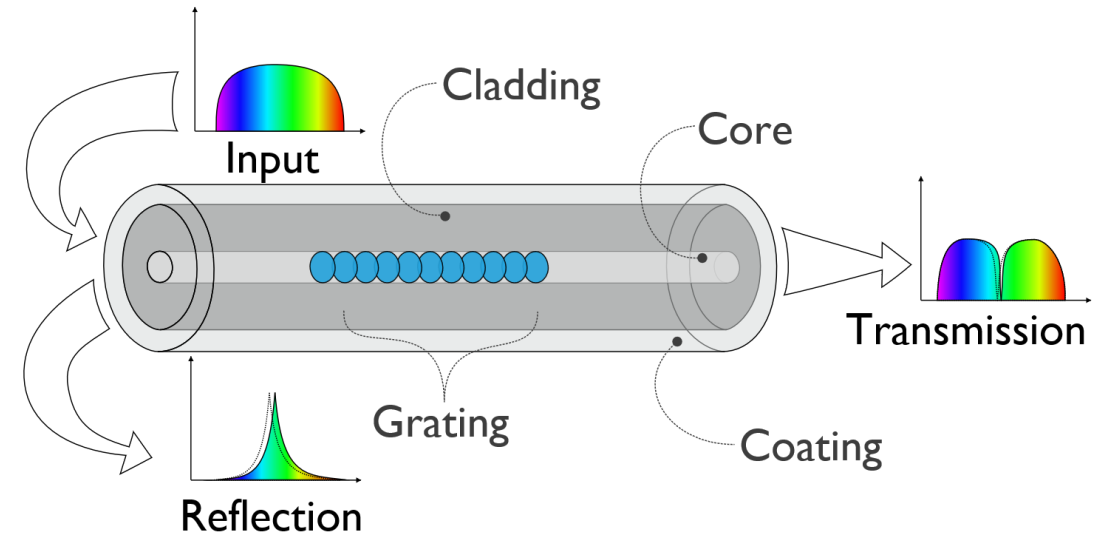
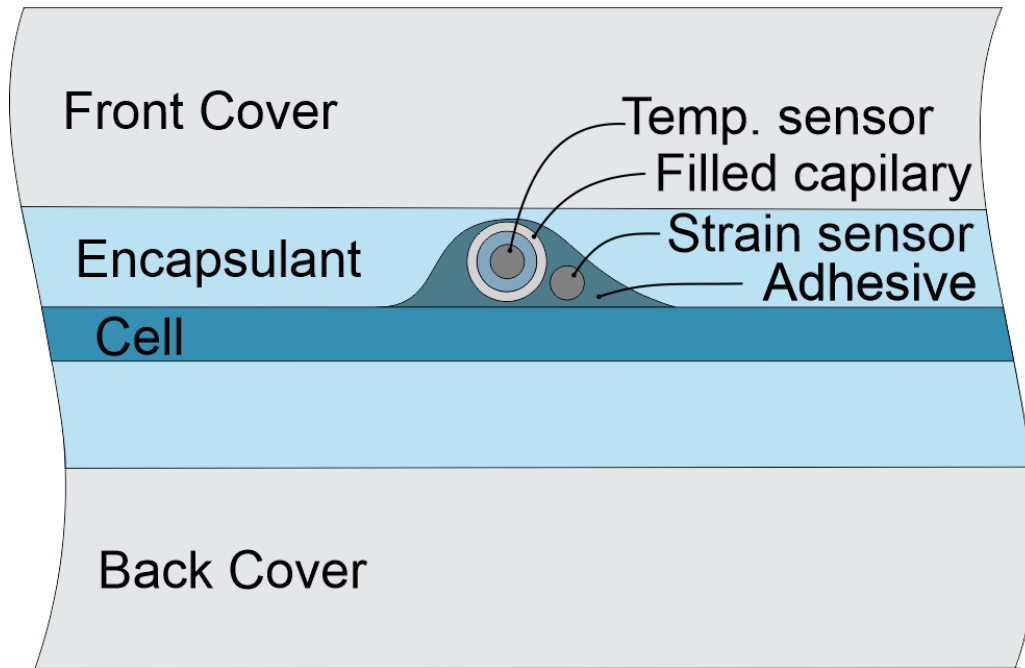
- The use of embedded optical sensors enables in-situ characterization  $\epsilon, T$  at various stages in the development process
- Using these sensors, simulations can be validated for both lab and field conditions on a quantitative basis.
- Accelerated stress tests using the sensors provides more insight on internal deformation mechanisms and can thereby accelerates novel PV technology development as well



<sup>2</sup> P. Nivelles et al., Optical Strain and Temperature Sensing within Photovoltaic Laminates, EUPVSEC 2020

# PV-sense

PV-sense

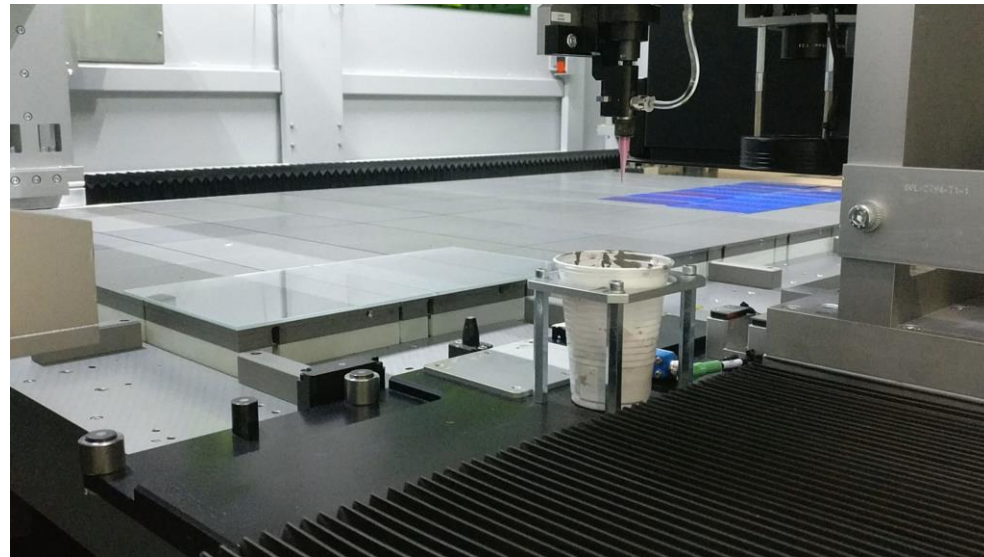


$$\ln\left(\frac{\lambda}{\lambda_0}\right) = (1 - Pe) \cdot \varepsilon + (\alpha + \eta) \cdot \Delta T$$

$\varepsilon$  → Elasto-optic coefficient  
 $(\alpha + \eta)$  → Thermo-optic coefficient

# PV-sense

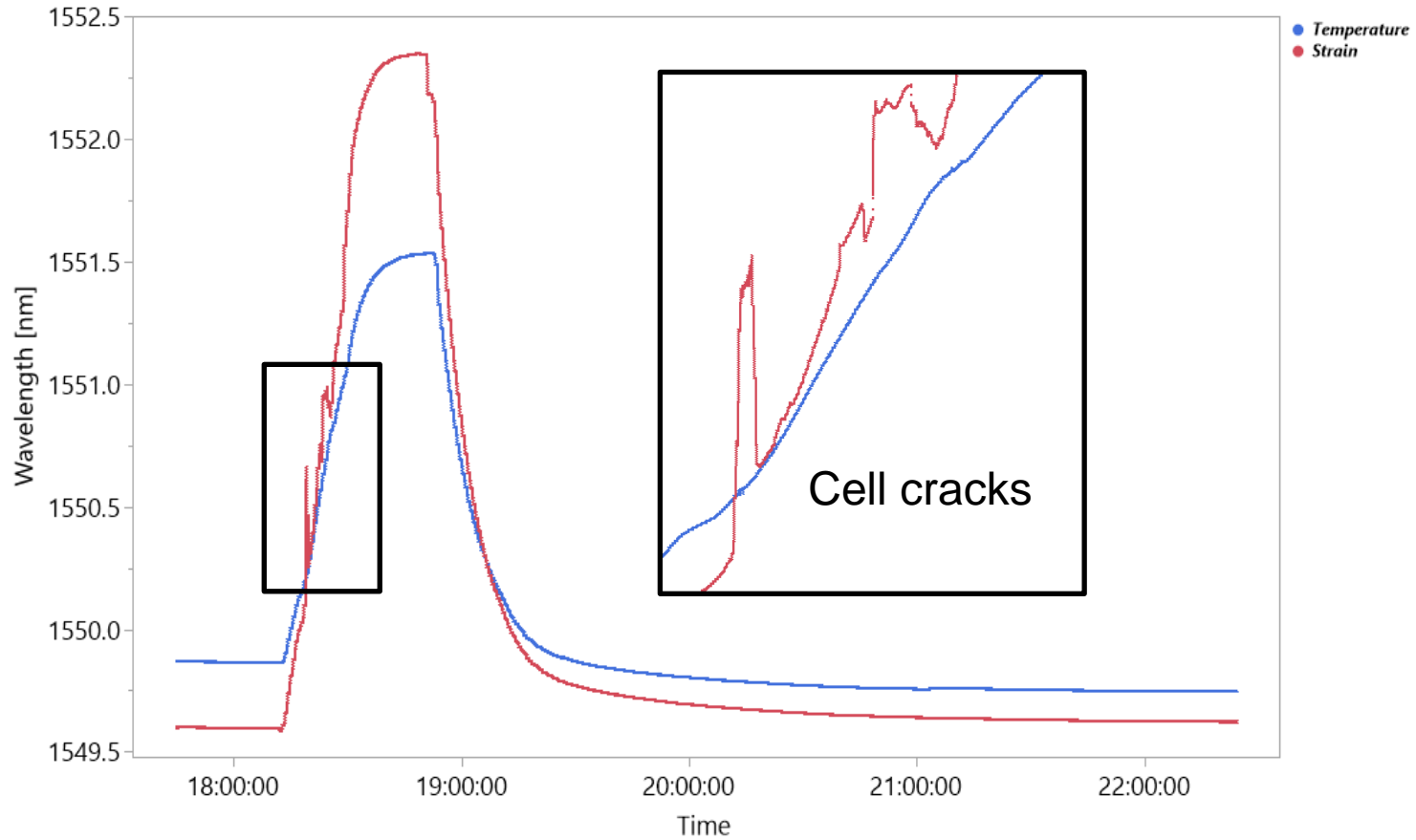
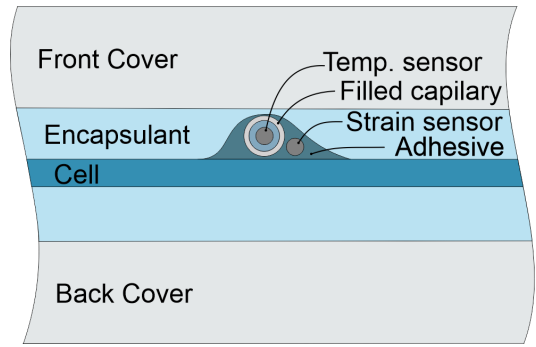
Expanding automation for integration





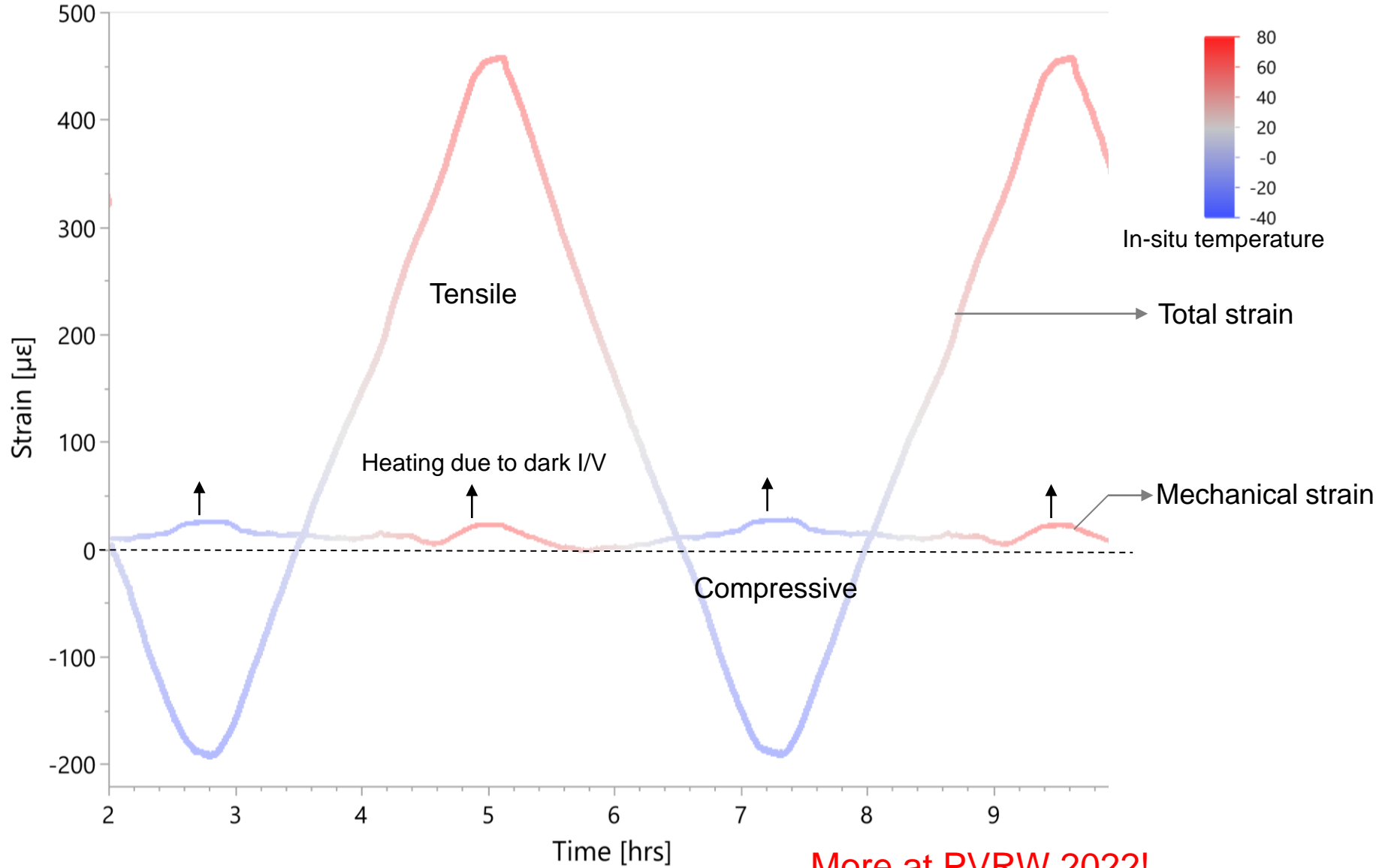
# PV-sense

## Investigation lamination



More at WCPEC 2022!

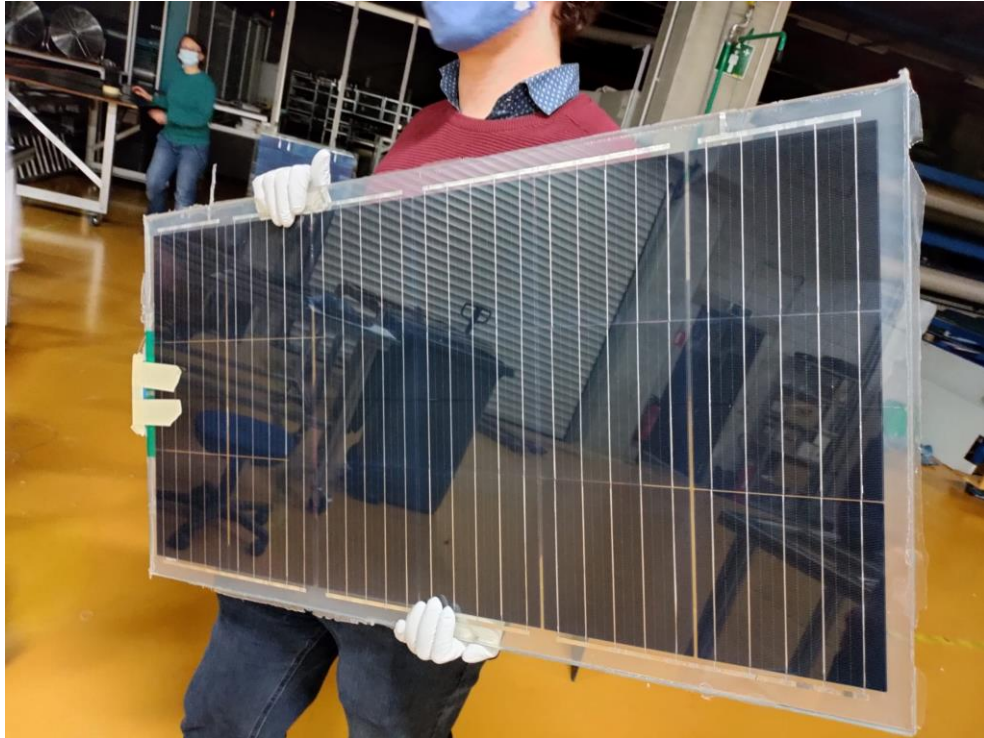
# PV-sense: investigating thermal cycling



More at PVRW 2022!

# PV-sense

Scaling up, full size demonstrators with in-field testing capabilities



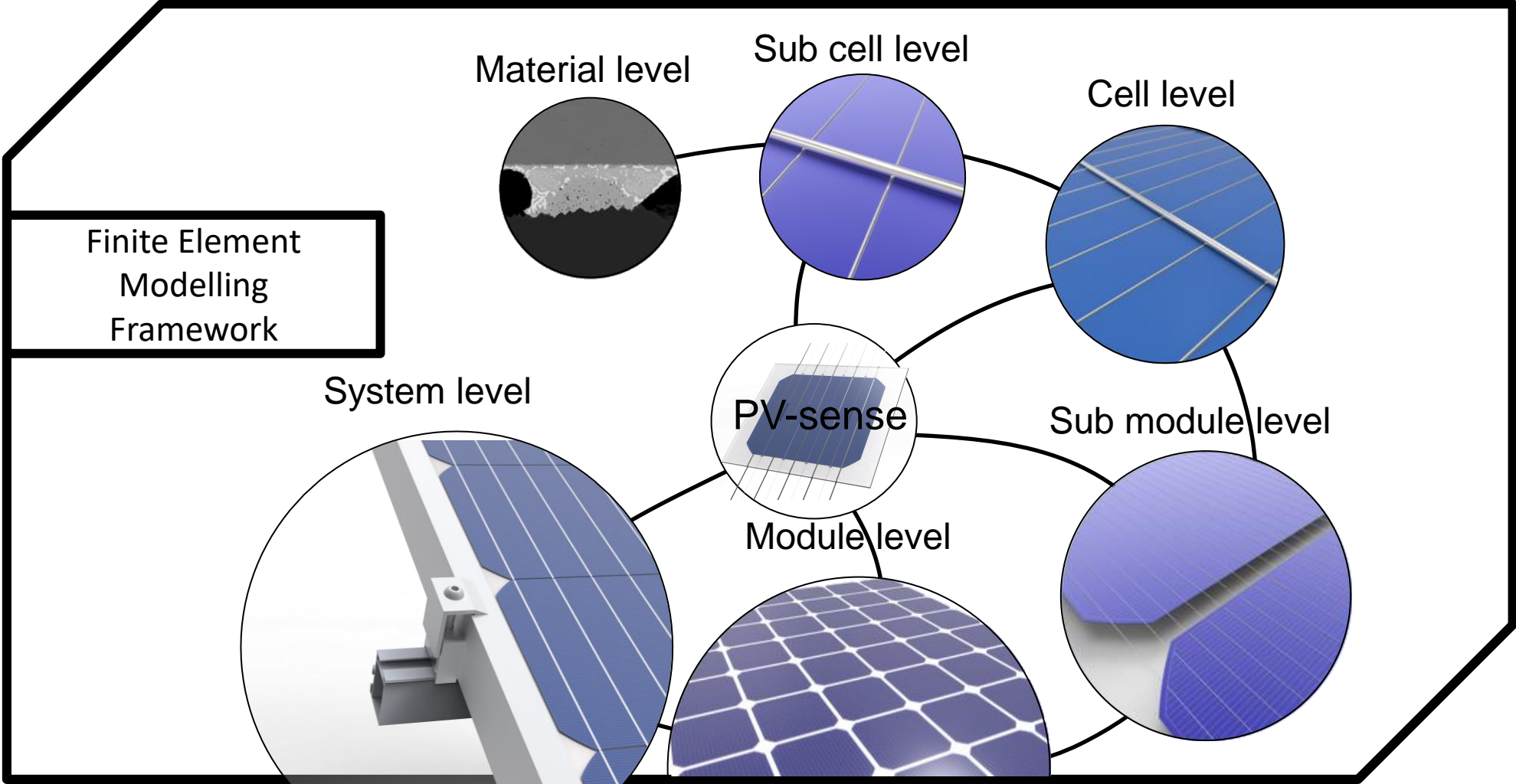
BIPV module with thermal packaging to monitor lamination behaviour and thermal effects in the field



Road elements are monitored real-time using thermo-mechanical packaging to study the load of passing vehicles



# A co-development approach



**Many thanks to all partners and colleagues who made this possible!**



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Framework Programme of the  
European Union

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